



TPL0102 具有非易失性存储器的 256 抽头双通道数字电位计

1 特性

- 两个分辨率为 256 个位置的电位计
- 非易失性存储器存储抽头位置
- 100k Ω 端到端电阻 (TPL0102-100)
- 短暂的抽头设置上电响应时间: < 100 μ s
- ± 0.5 最低有效位 (LSB) 积分非线性 (INL), ± 0.25 LSB 微分非线性 (DNL) (分压模式)
- 4ppm/ $^{\circ}$ C 比例温度系数
- 兼容 I²C 的串行接口
- 2.7V 至 5.5V 单电源运行
- ± 2.25 V 至 ± 2.75 V 双电源运行
- 工作温度范围: -40 $^{\circ}$ C 至 85 $^{\circ}$ C
- 关断模式
- 静电放电 (ESD) 性能测试符合 JESD 22 标准
 - 2000V 人体模型 (A114-B, II 类)
 - 1000V 充电器件模型 (C101)

2 应用

- 可调节增益放大器和偏移修整
- 可调节电源
- 设定点阈值的精度校准
- 传感器微调和校准
- 机械电位器的替代产品

3 说明

TPL0102 配有两个具备 256 个抽头位置的线性抽头数字电位计 (DPOT)。每个分压器可用作三端分压器或者两端变阻器。TPL0102-100 具有一个 100k Ω 端到端电阻。

TPL0102 配有非易失性存储器 (EEPROM)，可用于存储抽头位置。这一点的优势是即使在掉电期间也可存储抽头位置。因此，再次上电时便可自动恢复抽头位置。TPL0102 的内部寄存器可以使用 I²C 接口进行访问。

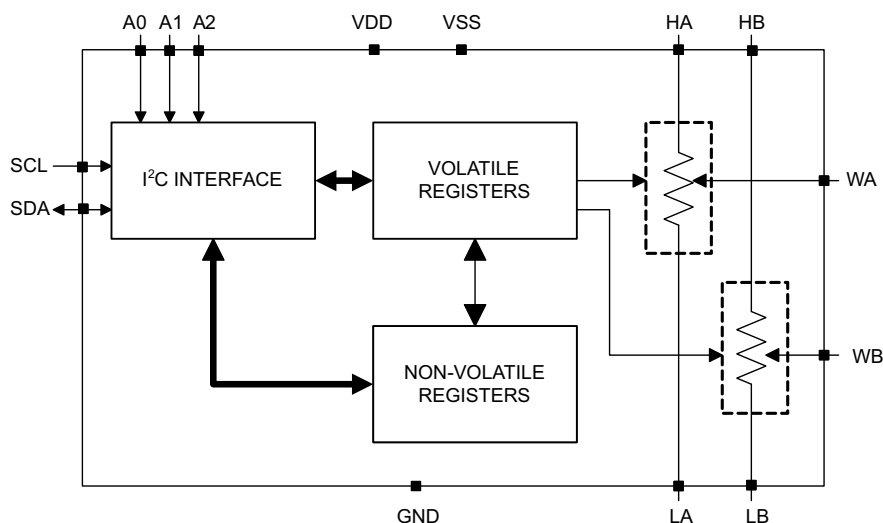
TPL0102 采用 14 引脚 MicroQFN 和 14 引脚薄型小外形尺寸 (TSSOP) 封装，额定温度范围为 -40 $^{\circ}$ C 至 85 $^{\circ}$ C。

器件信息⁽¹⁾

器件型号	封装	封装尺寸 (标称值)
TPL0102	X2QFN (14)	2.00mm x 2.00mm
	TSSOP (14)	5.00mm x 4.40mm

(1) 要了解所有可用封装，请见数据表末尾的可订购产品附录。

简化电路原理图



目录

1	特性	1	7.5	Programming with I ² C	20
2	应用	1	7.6	Register Maps	25
3	说明	1	8	Application and Implementation	28
4	修订历史记录	2	8.1	Application Information	28
5	Pin Configuration and Functions	3	8.2	Typical Applications	28
6	Specifications	4	9	Power Supply Recommendations	34
6.1	Absolute Maximum Ratings	4	9.1	Power Sequence	34
6.2	ESD Ratings	4	9.2	Wiper Position Upon Power Up	34
6.3	Recommended Operating Conditions	4	9.3	Dual-Supply vs Single-Supply	34
6.4	Thermal Information	4	10	Layout	35
6.5	Electrical Characteristics	5	10.1	Layout Guidelines	35
6.6	Operating Characteristics	6	10.2	Layout Example	35
6.7	Timing Requirements	7	11	器件和文档支持	36
6.8	Typical Characteristics	8	11.1	社区资源	36
7	Detailed Description	11	11.2	商标	36
7.1	Overview	11	11.3	静电放电警告	36
7.2	Functional Block Diagram	12	11.4	Glossary	36
7.3	Feature Description	12	12	机械、封装和可订购信息	36
7.4	Device Functional Modes	13			

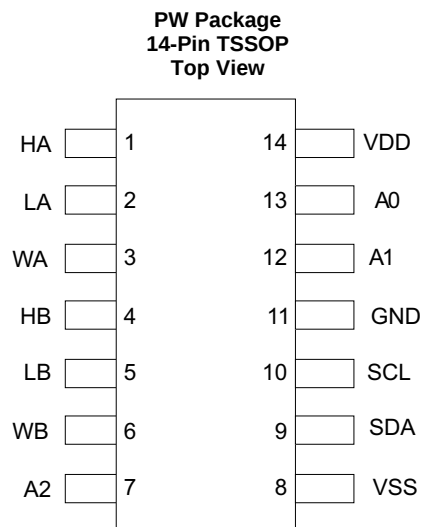
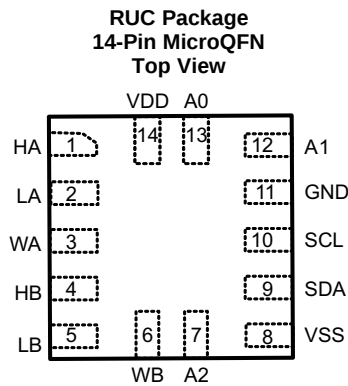
4 修订历史记录

注：之前版本的页码可能与当前版本有所不同。

Changes from Revision B (August 2011) to Revision C	Page
• 已添加 ESD 额定值表，特性 描述部分，器件功能模式，应用和实施部分，电源相关建议部分，布局部分，器件和文档支持部分以及机械、封装和可订购信息部分	1

Changes from Revision A (March 2011) to Revision B	Page
• Added <i>Recommended Operating Conditions</i> table.	4

5 Pin Configuration and Functions



Pin Functions

PIN		I/O	DESCRIPTION
NAME	NO.		
HA	1	I/O	High terminal of potentiometer A
LA	2	I/O	Low terminal of potentiometer A
WA	3	I/O	Wiper terminal of potentiometer A
HB	4	I/O	High terminal of potentiometer B
LB	5	I/O	Low terminal of potentiometer B
WB	6	I/O	Wiper terminal of potentiometer B
A2	7	I	I²C address bit 2
VSS	8	–	Negative power supply pin (Dual-Supply Operation) or tied to GND (Single-Supply Operation)
SDA	9	I/O	I²C data I/O
SCL	10	I	I²C clock Input
GND	11	–	Ground
A1	12	I	I²C address bit 1
A0	13	I	I²C address bit 0
VDD	14	–	Positive power supply pin

6 Specifications

6.1 Absolute Maximum Ratings⁽¹⁾⁽²⁾⁽³⁾

		MIN	MAX	UNIT
V _{DD} to GND	Supply voltage	−0.3	7	V
V _{SS} to GND		−7	0.3	V
V _{DD} to V _{SS}			7	V
V _H , V _L , V _W	Voltage at resistor terminals	V _{SS} − 0.3	V _{DD} + 0.3	V
V _I	Digital input voltage	−0.3	V _{DD} + 0.3	V
I _H , I _L , I _W	Pulse current		±20	mA
	Continuous current		±2	mA
T _{stg}	Storage temperature	−65	150	°C

- (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.
- (2) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.
- (3) All voltages are with respect to ground, unless otherwise specified.

6.2 ESD Ratings

		VALUE	UNIT
V _(ESD) Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±2000	V
	Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾	±1000	

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 500-V HBM is possible with the necessary precautions.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 250-V CDM is possible with the necessary precautions.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V _{DD}	Single supply operation (V _{SS} = 0 V)	2.7	5.5	V
	Dual supply operation (V _{SS} = −V _{DD})	2.25	2.75	
V _H , V _L	Terminal voltage range	V _{SS}	V _{DD}	V
V _{IH}	Digital input voltage high (SCL, SDA, A0, A1, A2)	0.7 × V _{DD}	5.5	V
V _{IL}	Digital input voltage low (SCL, SDA, A0, A1, A2)	0	0.3 × V _{DD}	V
I _W	Wiper current		±2	mA
T _A	Ambient temperature	−40	85	°C

6.4 Thermal Information

THERMAL METRIC ⁽¹⁾		TPL0102		UNIT
		PW (TSSOP)	RUC (X2QFN)	
		14 PINS	14 PINS	
R _{θJA}	Junction-to-ambient thermal resistance	112.9	119.4	°C/W
R _{θJC(top)}	Junction-to-case (top) thermal resistance	39.9	51.3	°C/W
R _{θJB}	Junction-to-board thermal resistance	55.9	59.0	°C/W
Ψ _{JT}	Junction-to-top characterization parameter	3.5	1.2	°C/W
Ψ _{JB}	Junction-to-board characterization parameter	55.2	59.0	°C/W

- (1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

6.5 Electrical Characteristics

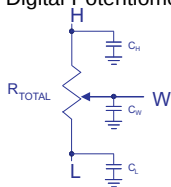
$V_{DD} = 2.7 \text{ V to } 5.5 \text{ V}$, $V_{SS} = 0 \text{ V}$, $V_H = V_{DD}$, $V_L = \text{GND}$, $T_A = -40^\circ\text{C to } 85^\circ\text{C}$ (unless otherwise noted). Typical values are at $V_{DD} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted).

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
R_{TOT}	End-to-End resistance (Between H and L Terminals)		80	100	120	k Ω
R_H , R_L	Terminal resistance			60	200	Ω
R_W	Wiper resistance			25	100	Ω
C_H , $C_L^{(1)(2)}$	Terminal capacitance			22		pF
$C_W^{(1)(2)}$	Wiper capacitance			16		pF
I_{LKG}	Terminal leakage current	$V_H = V_{SS} \text{ to } V_{DD}$, $V_L = \text{Floating}$ OR $V_L = V_{SS} \text{ to } V_{DD}$, $V_H = \text{Floating}$		0.1	1	μA
TC_R	Resistance temperature coefficient	Input Code = 0x80h		92		ppm/ $^\circ\text{C}$
$R_{TOT,MATCH}$	Channel-to-channel resistance match			0.1		%
Voltage Divider Mode						
$INL^{(3)(4)}$	Integral non-linearity		–0.5		0.5	LSB
$DNL^{(3)(5)}$	Differential non-linearity		–0.25		0.25	LSB
$ZS_{ERROR}^{(6)(7)}$	Zero-scale error		0	0.1	2	LSB
$FS_{ERROR}^{(6)(8)}$	Full-scale error		–2	–0.1	0	LSB
$MATCH_{VDM}^{(6)(9)}$	Channel-to-Channel matching	Wiper at the same tap position, same voltage at all H and same voltage at all L terminals	–2		2	LSB
TC_{VDM}	Ratiometric temperature coefficient	Wiper set at mid-scale		4		ppm/ $^\circ\text{C}$
BW	Bandwidth	Wiper set at mid-scale $C_{LOAD} = 10 \text{ pF}$		229		kHz
t_{SW}	Wiper setting time			3.6		μs
THD	Total harmonic distortion	$V_H = 1 \text{ V}_{RMS}$ at 1 kHz, $V_L = (V_{DD} - V_{SS})/2$, Measurement at pin W		0.03		%
X_{TALK}	Cross talk	$f_H = 1 \text{ kHz}$, $V_L = \text{GND}$, Measurement at pin W		–82		dB

- (1) Terminal and Wiper Capacitance extracted from self admittance of three port network measurement

$$Y_{ii} = \frac{I_i}{V_i} \Big|_{V_k=0 \text{ for } k \neq i}$$

- (2) Digital Potentiometer Macromodel



- (3) $LSB = (V_{MEAS}[\text{code } 255] - V_{MEAS}[\text{code } 0]) / 255$
(4) $INL = ((V_{MEAS}[\text{code } x] - V_{MEAS}[\text{code } 0]) / LSB) - [\text{code } x]$
(5) $DNL = ((V_{MEAS}[\text{code } x] - V_{MEAS}[\text{code } x-1]) / LSB) - 1$
(6) $IDEAL_LSB = (V_H - V_L) / 256$
(7) $ZS_{ERROR} = V_{MEAS}[\text{code } 0] / IDEAL_LSB$
(8) $FS_{ERROR} = [(V_{MEAS}[\text{code } 255] - (V_H - V_L)) / IDEAL_LSB] + 1$
(9) $MATCH_{VDM} = (V_{MEAS_A}[\text{code } x] - V_{MEAS_B}[\text{code } x]) / IDEAL_LSB$

Electrical Characteristics (continued)

$V_{DD} = 2.7\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$, $V_H = V_{DD}$, $V_L = \text{GND}$, $T_A = -40^\circ\text{C to }85^\circ\text{C}$ (unless otherwise noted). Typical values are at $V_{DD} = 5\text{ V}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted).

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
RHEOSTAT MODE (Measurements between W and L with H not connected, or between W and H with L not connected)					
RINL ⁽¹⁰⁾⁽¹¹⁾	Integral non-linearity	–1		1	LSB
RDNL ⁽¹⁰⁾⁽¹²⁾	Differential non-linearity	–0.5		0.5	LSB
OFFSET _{RM} ⁽¹³⁾⁽¹⁴⁾	Offset	0	0.2	2	LSB
MATCH _{RM} ⁽¹³⁾⁽¹⁵⁾	Channel-to-Channel matching	–2		2	LSB
BW	Bandwidth	Code = 0x00h, L Floating, Input applied to W, Measure at H, C _{LOAD} = 10 pF			54 kHz

(10) $RLSB = (R_{MEAS}[\text{code } 255] - R_{MEAS}[\text{code } 0]) / 255$

(11) $RINL = (R_{MEAS}[\text{code } x] - R_{MEAS}[\text{code } 0]) / RLSB - [\text{code } x]$

(12) $RDNL = (R_{MEAS}[\text{code } x] - R_{MEAS}[\text{code } x-1]) / RLSB - 1$

(13) $IDEAL_RLSB = R_{TOT} / 256$

(14) $OFFSET_{RM} = R_{MEAS}[\text{code } 0] / IDEAL_RLSB$

(15) $MATCH_{RM} = (R_{MEAS_A}[\text{code } x] - R_{MEAS_B}[\text{code } x]) / IDEAL_RLSB$

6.6 Operating Characteristics

$V_{DD} = 2.7\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$, $V_H = V_{DD}$, $V_L = \text{GND}$, $T_A = -40^\circ\text{C to }85^\circ\text{C}$ (unless otherwise noted). Typical values are at $V_{DD} = 5\text{ V}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted).

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
I _{DD(STBY)}	V _{DD} standby current		0.2	1	μA
I _{SS(STBY)}	V _{SS} standby current	–1	–0.2		μA
I _{DD(SHUTDOWN)}	V _{DD} shutdown current		0.2	1	μA
I _{SS(SHUTDOWN)}	V _{SS} shutdown current	–1	–0.2		μA
I _{DD}	V _{DD} current during non-volatile write		200		μA
I _{SS}	V _{SS} current during non-volatile write	–200			μA
I _{LKG(DIG)}	Digital pins leakage current (A0, A1, A2, SDA, and SCL)	–1		1	μA
V _{POR}	Power-on recall voltage		23		V
EEPROM Specification					
	EEPROM endurance		100 000		Cycles
	EEPROM retention	T _A = 85°C	100		Years
t _{WC}	Non-volatile write cycle time		20		ms
Wiper Timing Characteristics					
t _(WRT)	Wiper response time	SCL falling edge of last bit of wiper data byte to wiper new position	600		ns
t _(SR)	Wiper position recall time from shut-down mode	SCL falling edge of last bit of ACR data byte to wiper stored position and H connection	800		ns
t _(D)	Power-up delay	V _{DD} above V _{POR} , to wiper initial value register recall completed, and I ² C interface in standby mode	35	100	μs
C _(PIN)	Pin capacitance	A0, A1, A2, SDA, SCL pins	7		pF

Operating Characteristics (continued)

$V_{DD} = 2.7\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$, $V_H = V_{DD}$, $V_L = \text{GND}$, $T_A = -40^\circ\text{C to }85^\circ\text{C}$ (unless otherwise noted). Typical values are at $V_{DD} = 5\text{ V}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted).

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
I²C Interface Specifications					
V_{IH}	Input high voltage		$0.7 \times V_{DD}$	5.5	V
V_{IL}	Input low voltage	0	$0.3 \times V_{DD}$		V
V_{OL}	Output low voltage	SDA pin, $I_{OL} = 4\text{ mA}$		0.4	V
C_{IN}	Pin capacitance	A0, A1, A2, SDA, SCL pins		7	pF

6.7 Timing Requirements

$V_{DD} = 2.7\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$, $V_H = V_{DD}$, $V_L = \text{GND}$, $T_A = -40^\circ\text{C to }85^\circ\text{C}$ (unless otherwise noted). Typical values are at $V_{DD} = 5\text{ V}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted).

		STANDARD MODE I ² C BUS		FAST MODE I ² C BUS		UNIT
		MIN	MAX	MIN	MAX	
I ² C Interface Timing Requirements						
f _{SCL}	I ² C clock frequency	0	100	0	400	kHz
t _{SCH}	I ² C clock high time	4		0.6		μs
t _{SCL}	I ² C clock low time	4.7		1.3		μs
t _{sp}	I ² C spike time	0	50	0	50	ns
t _{SDS}	I ² C serial data setup time	250		100		ns
t _{SDH}	I ² C serial data hold time	0		0		ns
t _{ICR}	I ² C input rise time		1000	20 + 0.1C _b ⁽¹⁾	300	ns
t _{ICF}	I ² C input fall time		300	20 + 0.1C _b ⁽¹⁾	300	ns
t _{ICF}	I ² C output fall time, 10 pF to 400 pF bus		300	20 + 0.1C _b ⁽¹⁾	300	ns
t _{BUF}	I ² C bus free time between stop and start	4.7		1.3		μs
t _{STS}	I ² C start or repeater start condition setup time	4.7		1.3		μs
t _{STH}	I ² C start or repeater start condition hold time	4		0.6		μs
t _{SPS}	I ² C stop condition setup time	4		0.6		μs
t _{VD(DATA)}	Valid data time, SCL low to SDA output valid		1		1	μs
3t _{VD(ACK)}	Valid data time of ACK condition, ACK signal from SCL low to SDA (out) low		1		1	μs

(1) C_b = total capacitance of one bus line in pF

6.8 Typical Characteristics

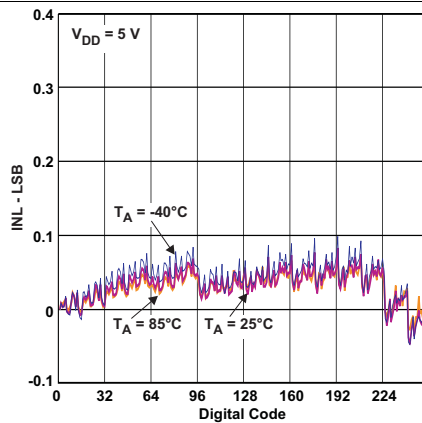


Figure 1. Voltage Divider Mode INL vs Digital Code ($V_{DD} = 5$ V)

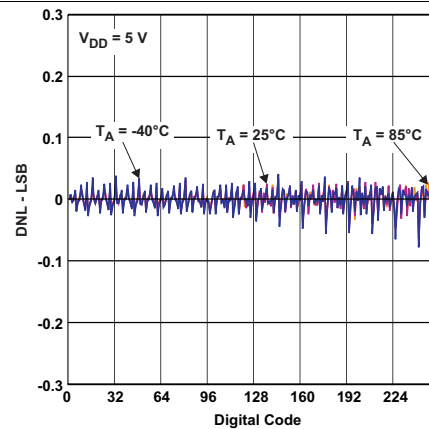


Figure 2. Voltage Divider Mode DNL vs Digital Code ($V_{DD} = 5$ V)

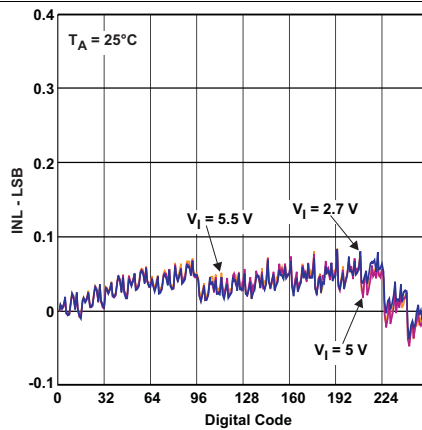


Figure 3. Voltage Divider Mode INL vs Digital Code (25°C)

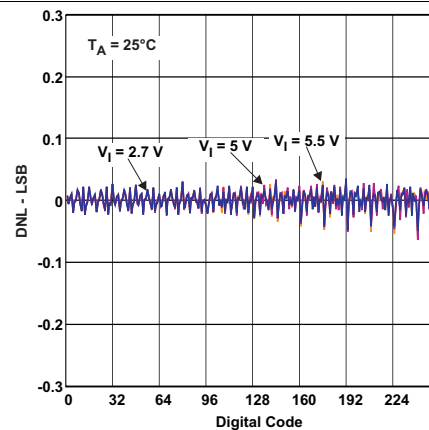


Figure 4. Voltage Divider Mode DNL vs Digital Code (25°C)

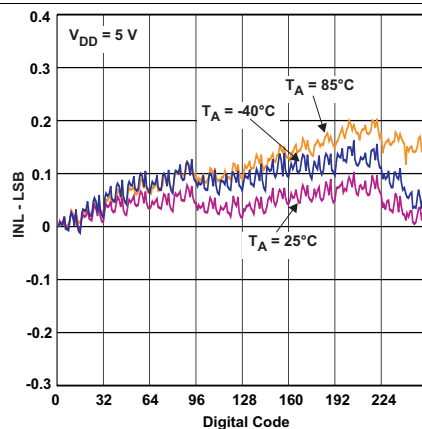


Figure 5. Rheostat Mode RINL vs Digital Code ($V_{DD} = 5$ V)

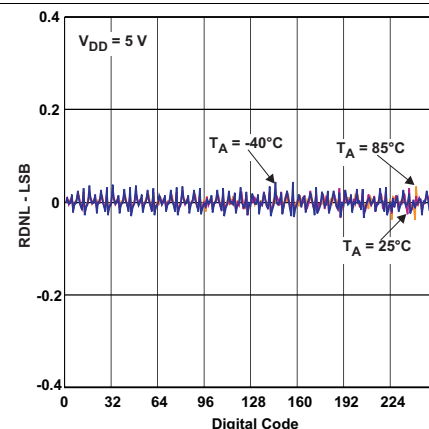


Figure 6. Rheostat Mode RDNL vs Digital Code ($V_{DD} = 5$ V)

Typical Characteristics (continued)

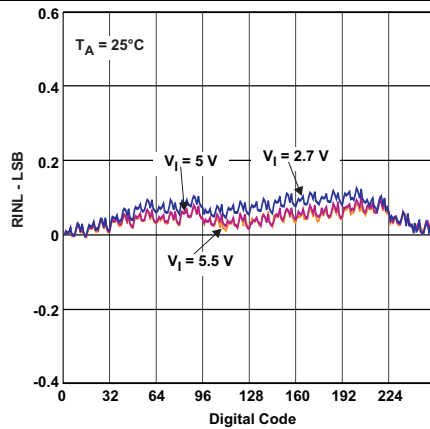


Figure 7. Rheostat Mode RINL vs Digital Code (25°C)

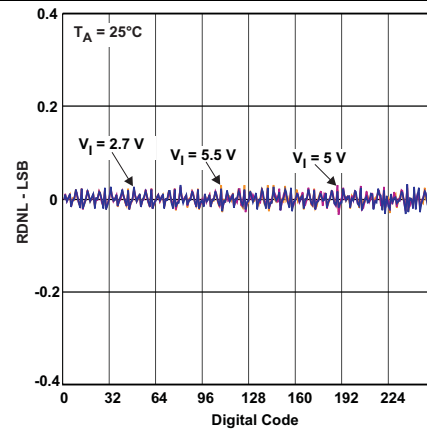


Figure 8. Rheostat Mode RDNL vs Digital Code (25°C)

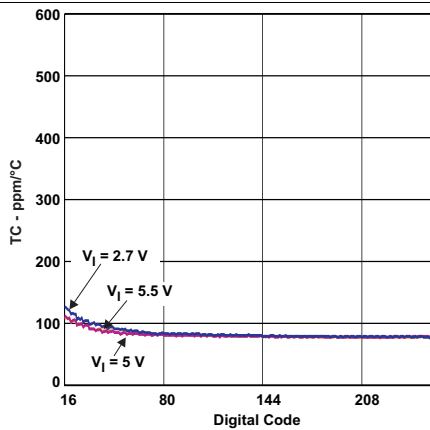


Figure 9. Rheostat Mode TC_R vs Digital Code

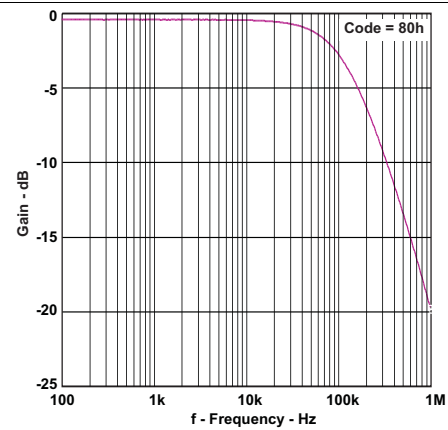


Figure 10. Rheostat Mode Gain vs Frequency

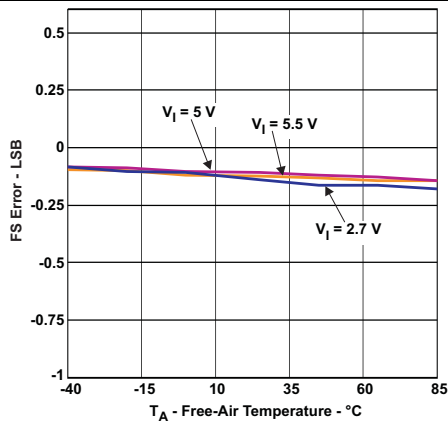


Figure 11. Voltage Divider Mode FS Error vs Temperature

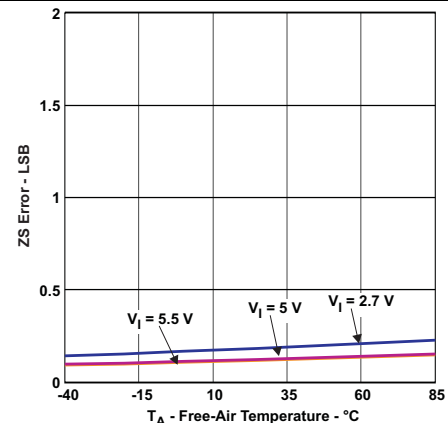


Figure 12. Voltage Divider Mode ZS Error vs Temperature

Typical Characteristics (continued)

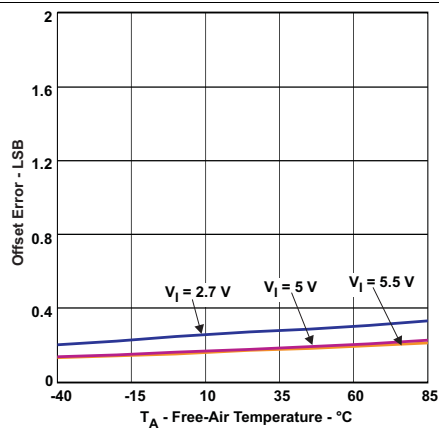


Figure 13. Rheostat Mode Offset Error vs Temperature

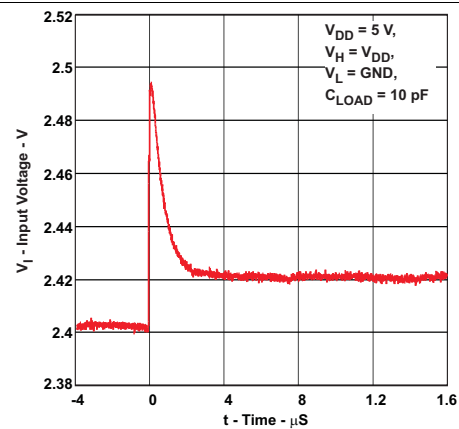


Figure 14. Midscale Wiper Glitch (0x7Fh to 0x80h)

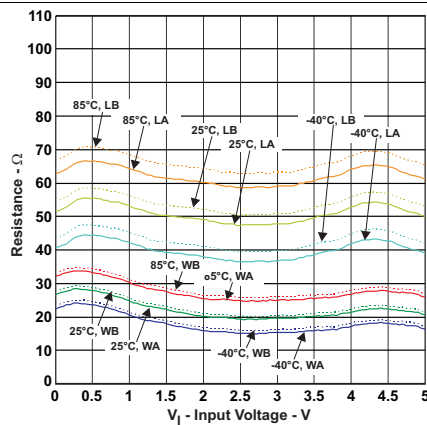


Figure 15. Wiper to Low Terminal Resistance ($V_{DD} = 5\text{ V}$)

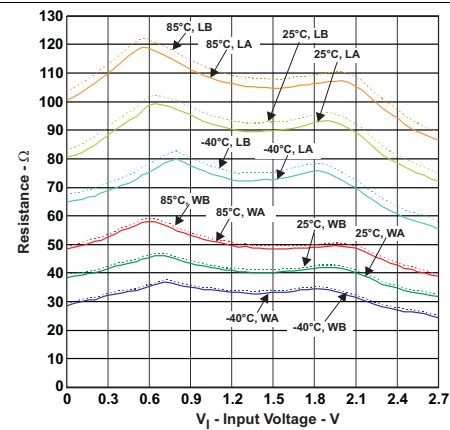


Figure 16. Wiper to Low Terminal Resistance ($V_{DD} = 2.7\text{ V}$)

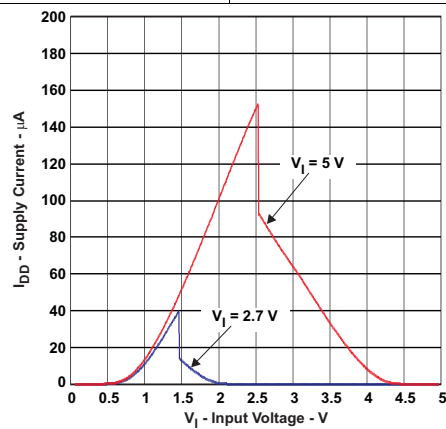


Figure 17. Supply Current vs Digital Input Voltage

7 Detailed Description

7.1 Overview

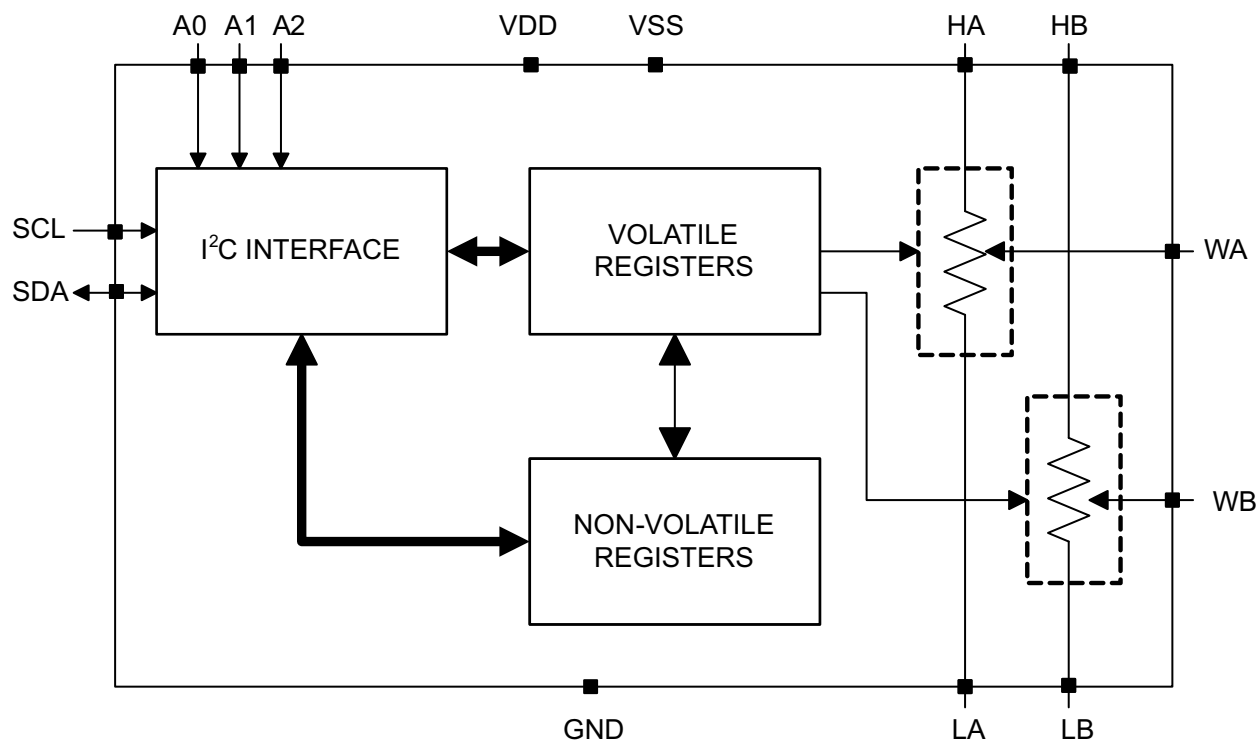
The TPL0102 has two linear-taper digital potentiometers with 256 wiper positions and an end-to-end resistance of 100 k Ω . Each potentiometer can be used as a three-terminal potentiometer or as a two-terminal rheostat. The two potentiometers can both be used in Voltage Divider Mode, Rheostat Mode, or Shutdown Mode at the same time, or any combination of those modes. For example, potentiometer A can be used in Voltage Divider Mode and potentiometer B can be used in Voltage Divider Mode, or potentiometer A can be used in Voltage Divider Mode and potentiometer B can be used in Rheostat Mode. The two potentiometers are functionally independent of one another.

The High (H) and Low (L) terminals of the TPL0102 are equivalent to the fixed terminals of a mechanical potentiometer. The H and L terminals do not have any polarity restrictions (H can be at a higher voltage than L, or L can be at a higher voltage than H). The position of the wiper (W) terminal is controlled by the value in the Wiper Resistance (WR) 8-bit register. When the WR register contains all zeroes (zero-scale), the wiper terminal is closest to its L terminal. As the value of the WR register increases from all zeroes to all ones (full-scale), the wiper moves monotonically from the position closest to L terminal to the position closest to the H terminal. At the same time, the resistance between W and L increases monotonically, whereas the resistance between W and H decreases monotonically.

The TPL0102 has non-volatile memory (EEPROM) which can be used to store the wiper position. When the device is powered down, the last value stored in the Initial Value Register (IVR) will be maintained in the non-volatile memory. When power is restored, the contents of the IVR are automatically recalled and loaded into the corresponding WR register to set the wipers. The internal registers of the TPL0102 can be accessed using the I²C interface. The factory-programmed default value for the IVR upon power up is 0x80h (1000 0000). The WR register can be written to directly without first writing to the IVR, depending upon the setting of the volatile memory (VOL) in the [ACR \(Access Control Register\)](#). If the WR register is written to directly without writing to the IVR as well, this results in the wiper position changing to a desired position, but the position will not be stored in memory and will not be reloaded upon powering up the device.

With one TPL0102, a variable resistor with 512 settings can be used since there are two potentiometers in one TPL0102. In order to achieve this, the two potentiometers should be in Rheostat Mode and wired so that terminal L of potentiometer B is tied to terminal W of potentiometer A. This will provide 512 settings between terminal L of potentiometer A and terminal W of potentiometer B.

7.2 Functional Block Diagram



7.3 Feature Description

The TPL0102 has two linear-taper digital potentiometers (DPOTs) with 256 wiper positions. Each potentiometer can be used as a three-terminal potentiometer or a two-terminal rheostat. The TPL0102-100 has an end-to-end resistance of 100 k Ω with a 20% end-to-end resistance tolerance. Non-volatile memory (EEPROM) can be used to store the wiper position allowing the wiper position to be stored even during power-off and automatically reinstated after power-on. The internal registers of the TPL0102 can be accessed using the I²C digital interface. The TPL0102 is available in a 14-pin MicroQFN (2.00 mm x 2.00 mm) and 14-pin TSSOP package.

7.4 Device Functional Modes

7.4.1 Shutdown Mode

The TPL0102 can be put in Shutdown Mode by executing the proper command in the [ACR \(Access Control Register\)](#). Please see the [TPL0102 Register Map](#) for more details. When active, this feature causes terminal H to become high impedance.

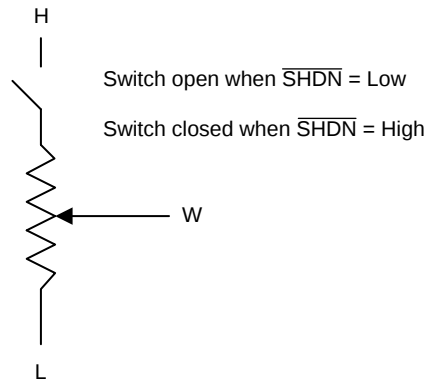


Figure 18. Equivalent Circuit for Shutdown Mode

7.4.2 Voltage Divider Mode

The digital potentiometer generates a voltage divider when all three terminals are used. The voltage divider at wiper-to-H and wiper-to-L is proportional to the input voltage at H to L.

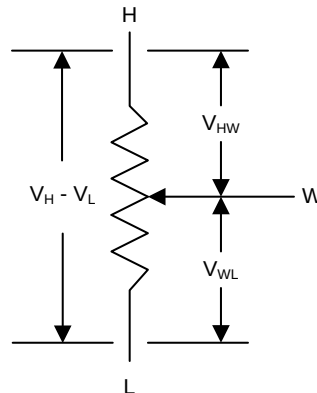


Figure 19. Equivalent Circuit for Voltage Divider Mode

For example, connecting terminal H to 5 V and terminal L to ground, the output voltage at terminal W can range from 0 V to 5 V. The general equation defining the output voltage at terminal W for any valid input voltage applied to terminal H and terminal L is

$$V_W = V_{WL} = (V_H - V_L) \times \frac{D}{256} \quad (1)$$

The voltage difference between terminal H and terminal W can also be calculated

$$V_{HW} = (V_H - V_L) \times \left(1 - \left(\frac{D}{256}\right)\right)$$

where

- D is the decimal value of the wiper code. (2)

Device Functional Modes (continued)

7.4.3 Rheostat Mode

The TPL0102 operates in rheostat mode when only two terminals are used as a variable resistor. The variable resistance can either be between terminal H and terminal W or between terminal L and terminal W. The unused terminal can be left floating or it can be tied to terminal W. The nominal resistance between terminal H and terminal L is 100 kΩ and has 256 tap points accessed by the wiper terminal. The 8-bit volatile register value is used to determine one of the 256 possible wiper positions.

In rheostat mode, to set the resistance between terminal H and terminal W, the potentiometer can be configured in two possible ways.

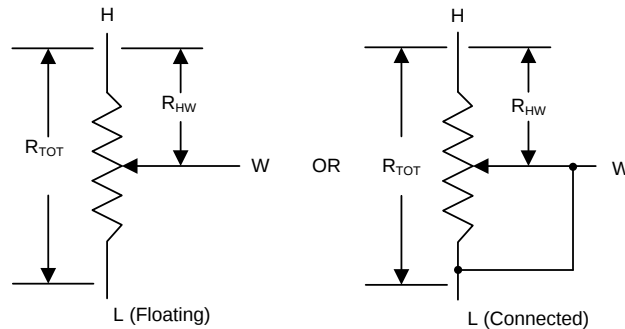


Figure 20. Equivalent Circuit for Rheostat Mode with Terminal H to Terminal W Resistance

The general equation for determining the digitally programmed output resistance between Terminal H and Terminal W is:

$$R_{HW} = R_{TOT} \times \left(1 - \left(\frac{D}{256} \right) \right)$$

where

- R_{TOT} is the end-to-end resistance between terminal H and terminal L.
- D is the decimal value of the wiper code. (3)

Similarly, to set the resistance between terminal L and terminal W, the potentiometer can be configured in two possible ways.

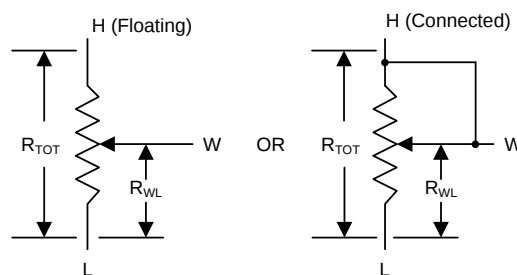


Figure 21. Equivalent Circuit for Rheostat Mode with Terminal L to Terminal W Resistance

The general equation for determining the digitally programmed output resistance between terminal L and terminal W is

$$R_{WL} = R_{TOT} \times \frac{D}{256}$$

where

- R_{TOT} is the end-to-end resistance between terminal H and terminal L.
- D is the decimal value of the wiper code. (4)

Device Functional Modes (continued)

The following table shows the ideal values for DPOT with End-to End resistance of 100 k Ω . The absolute values of resistance can vary significantly but the Ratio (R_{WL}/R_{HW}) is extremely accurate.

The linearity values are "relative" linearity values (i.e. linearity after zero-scale and full-scale offset errors are removed). Please take this into account when expecting a certain absolute accuracy since some error will be introduced once you get close in magnitude to the offset errors.

Step	Hex	Binary	R_{WL} (k Ω)	R_{HW} (k Ω)	R_{WL}/R_{HW}
0 (zero-scale)	0x00h	0000 0000	0.00	100.00	0.00
1	0x01h	0000 0001	0.39	99.61	0.00
2	0x02h	0000 0010	0.78	99.22	0.01
3	0x03h	0000 0011	1.17	98.83	0.01
4	0x04h	0000 0100	1.56	98.44	0.02
5	0x05h	0000 0101	1.95	98.05	0.02
6	0x06h	0000 0110	2.34	97.66	0.02
7	0x07h	0000 0111	2.73	97.27	0.03
8	0x08h	0000 1000	3.13	96.88	0.03
9	0x09h	0000 1001	3.52	96.48	0.04
10	0x0Ah	0000 1010	3.91	96.09	0.04
11	0x0Bh	0000 1011	4.30	95.70	0.04
12	0x0Ch	0000 1100	4.69	95.31	0.05
13	0x0Dh	0000 1101	5.08	94.92	0.05
14	0x0Eh	0000 1110	5.47	94.53	0.06
15	0x0Fh	0000 1111	5.86	94.14	0.06
16	0x10h	0001 0000	6.25	93.75	0.07
17	0x11h	0001 0001	6.64	93.36	0.07
18	0x12h	0001 0010	7.03	92.97	0.08
19	0x13h	0001 0011	7.42	92.58	0.08
20	0x14h	0001 0100	7.81	92.19	0.08
21	0x15h	0001 0101	8.20	91.80	0.09
22	0x16h	0001 0110	8.59	91.41	0.09
23	0x17h	0001 0111	8.98	91.02	0.10
24	0x18h	0001 1000	9.38	90.63	0.10
25	0x19h	0001 1001	9.77	90.23	0.11
26	0x1Ah	0001 1010	10.16	89.84	0.11
27	0x1Bh	0001 1011	10.55	89.45	0.12
28	0x1Ch	0001 1100	10.94	89.06	0.12
29	0x1Dh	0001 1101	11.33	88.67	0.13
30	0x1Eh	0001 1110	11.72	88.28	0.13
31	0x1Fh	0001 1111	12.11	87.89	0.14
32	0x20h	0010 0000	12.50	87.50	0.14
33	0x21h	0010 0001	12.89	87.11	0.15
34	0x22h	0010 0010	13.28	86.72	0.15
35	0x23h	0010 0011	13.67	86.33	0.16
36	0x24h	0010 0100	14.06	85.94	0.16
37	0x25h	0010 0101	14.45	85.55	0.17
38	0x26h	0010 0110	14.84	85.16	0.17
39	0x27h	0010 0111	15.23	84.77	0.18
40	0x28h	0010 1000	15.63	84.38	0.19
41	0x29h	0010 1001	16.02	83.98	0.19

TPL0102

ZHCSE79C – MARCH 2011–REVISED SEPTEMBER 2015

www.ti.com.cn

Step	Hex	Binary	R _{WL} (kΩ)	R _{HW} (kΩ)	R _{WL} /R _{HW}
42	0x2Ah	0010 1010	16.41	83.59	0.20
43	0x2Bh	0010 1011	16.80	83.20	0.20
44	0x2Ch	0010 1100	17.19	82.81	0.21
45	0x2Dh	0010 1101	17.58	82.42	0.21
46	0x2Eh	0010 1110	17.97	82.03	0.22
47	0x2Fh	0010 1111	18.36	81.64	0.22
48	0x30h	0011 0000	18.75	81.25	0.23
49	0x31h	0011 0001	19.14	80.86	0.24
50	0x32h	0011 0010	19.53	80.47	0.24
51	0x33h	0011 0011	19.92	80.08	0.25
52	0x34h	0011 0100	20.31	79.69	0.25
53	0x35h	0011 0101	20.70	79.30	0.26
54	0x36h	0011 0110	21.09	78.91	0.27
55	0x37h	0011 0111	21.48	78.52	0.27
56	0x38h	0011 1000	21.88	78.13	0.28
57	0x39h	0011 1001	22.27	77.73	0.29
58	0x3Ah	0011 1010	22.66	77.34	0.29
59	0x3Bh	0011 1011	23.05	76.95	0.30
60	0x3Ch	0011 1100	23.44	76.56	0.31
61	0x3Dh	0011 1101	23.83	76.17	0.31
62	0x3Eh	0011 1110	24.22	75.78	0.32
63	0x3Fh	0011 1111	24.61	75.39	0.33
64	0x40h	0100 0000	25.00	75.00	0.33
65	0x41h	0100 0001	25.39	74.61	0.34
66	0x42h	0100 0010	25.78	74.22	0.35
67	0x43h	0100 0011	26.17	73.83	0.35
68	0x44h	0100 0100	26.56	73.44	0.36
69	0x45h	0100 0101	26.95	73.05	0.37
70	0x46h	0100 0110	27.34	72.66	0.38
71	0x47h	0100 0111	27.73	72.27	0.38
72	0x48h	0100 1000	28.13	71.88	0.39
73	0x49h	0100 1001	28.52	71.48	0.40
74	0x4Ah	0100 1010	28.91	71.09	0.41
75	0x4Bh	0100 1011	29.30	70.70	0.41
76	0x4Ch	0100 1100	29.69	70.31	0.42
77	0x4Dh	0100 1101	30.08	69.92	0.43
78	0x4Eh	0100 1110	30.47	69.53	0.44
79	0x4Fh	0100 1111	30.86	69.14	0.45
80	0x50h	0101 0000	31.25	68.75	0.45
81	0x51h	0101 0001	31.64	68.36	0.46
82	0x52h	0101 0010	32.03	67.97	0.47
83	0x53h	0101 0011	32.42	67.58	0.48
84	0x54h	0101 0100	32.81	67.19	0.49
85	0x55h	0101 0101	33.20	66.80	0.50
86	0x56h	0101 0110	33.59	66.41	0.51
87	0x57h	0101 0111	33.98	66.02	0.51
88	0x58h	0101 1000	34.38	65.63	0.52
89	0x59h	0101 1001	34.77	65.23	0.53
90	0x5Ah	0101 1010	35.16	64.84	0.54

Step	Hex	Binary	R _{WL} (kΩ)	R _{HW} (kΩ)	R _{WL} /R _{HW}
91	0x5Bh	0101 1011	35.55	64.45	0.55
92	0x5Ch	0101 1100	35.94	64.06	0.56
93	0x5Dh	0101 1101	36.33	63.67	0.57
94	0x5Eh	0101 1110	36.72	63.28	0.58
95	0x5Fh	0101 1111	37.11	62.89	0.59
96	0x60h	0110 0000	37.50	62.50	0.60
97	0x61h	0110 0001	37.89	62.11	0.61
98	0x62h	0110 0010	38.28	61.72	0.62
99	0x63h	0110 0011	38.67	61.33	0.63
100	0x64h	0110 0100	39.06	60.94	0.64
101	0x65h	0110 0101	39.45	60.55	0.65
102	0x66h	0110 0110	39.84	60.16	0.66
103	0x67h	0110 0111	40.23	59.77	0.67
104	0x68h	0110 1000	40.63	59.38	0.68
105	0x69h	0110 1001	41.02	58.98	0.70
106	0x6Ah	0110 1010	41.41	58.59	0.71
107	0x6Bh	0110 1011	41.80	58.20	0.72
108	0x6Ch	0110 1100	42.19	57.81	0.73
109	0x6Dh	0110 1101	42.58	57.42	0.74
110	0x6Eh	0110 1110	42.97	57.03	0.75
111	0x6Fh	0110 1111	43.36	56.64	0.77
112	0x70h	0111 0000	43.75	56.25	0.78
113	0x71h	0111 0001	44.14	55.86	0.79
114	0x72h	0111 0010	44.53	55.47	0.80
115	0x73h	0111 0011	44.92	55.08	0.82
116	0x74h	0111 0100	45.31	54.69	0.83
117	0x75h	0111 0101	45.70	54.30	0.84
118	0x76h	0111 0110	46.09	53.91	0.86
119	0x77h	0111 0111	46.48	53.52	0.87
120	0x78h	0111 1000	46.88	53.13	0.88
121	0x79h	0111 1001	47.27	52.73	0.90
122	0x7Ah	0111 1010	47.66	52.34	0.91
123	0x7Bh	0111 1011	48.05	51.95	0.92
124	0x7Ch	0111 1100	48.44	51.56	0.94
125	0x7Dh	0111 1101	48.83	51.17	0.95
126	0x7Eh	0111 1110	49.22	50.78	0.97
127	0x7Fh	0111 1111	49.61	50.39	0.98
128	0x80h	1000 0000	50.00	50.00	1.00
129	0x81h	1000 0001	50.39	49.61	1.02
130	0x82h	1000 0010	50.78	49.22	1.03
131	0x83h	1000 0011	51.17	48.83	1.05
132	0x84h	1000 0100	51.56	48.44	1.06
133	0x85h	1000 0101	51.95	48.05	1.08
134	0x86h	1000 0110	52.34	47.66	1.10
135	0x87h	1000 0111	52.73	47.27	1.12
136	0x88h	1000 1000	53.13	46.88	1.13
137	0x89h	1000 1001	53.52	46.48	1.15
138	0x8Ah	1000 1010	53.91	46.09	1.17
139	0x8Bh	1000 1011	54.30	45.70	1.19

TPL0102

ZHCSE79C – MARCH 2011–REVISED SEPTEMBER 2015

www.ti.com.cn

Step	Hex	Binary	R _{WL} (kΩ)	R _{HW} (kΩ)	R _{WL} /R _{HW}
140	0x8Ch	1000 1100	54.69	45.31	1.21
141	0x8Dh	1000 1101	55.08	44.92	1.23
142	0x8Eh	1000 1110	55.47	44.53	1.25
143	0x8Fh	1000 1111	55.86	44.14	1.27
144	0x90h	1001 0000	56.25	43.75	1.29
145	0x91h	1001 0001	56.64	43.36	1.31
146	0x92h	1001 0010	57.03	42.97	1.33
147	0x93h	1001 0011	57.42	42.58	1.35
148	0x94h	1001 0100	57.81	42.19	1.37
149	0x95h	1001 0101	58.20	41.80	1.39
150	0x96h	1001 0110	58.59	41.41	1.42
151	0x97h	1001 0111	58.98	41.02	1.44
152	0x98h	1001 1000	59.38	40.63	1.46
153	0x99h	1001 1001	59.77	40.23	1.49
154	0x9Ah	1001 1010	60.16	39.84	1.51
155	0x9Bh	1001 1011	60.55	39.45	1.53
156	0x9Ch	1001 1100	60.94	39.06	1.56
157	0x9Dh	1001 1101	61.33	38.67	1.59
158	0x9Eh	1001 1110	61.72	38.28	1.61
159	0x9Fh	1001 1111	62.11	37.89	1.64
160	0xA0h	1010 0000	62.50	37.50	1.67
161	0xA1h	1010 0001	62.89	37.11	1.69
162	0xA2h	1010 0010	63.28	36.72	1.72
163	0xA3h	1010 0011	63.67	36.33	1.75
164	0xA4h	1010 0100	64.06	35.94	1.78
165	0xA5h	1010 0101	64.45	35.55	1.81
166	0xA6h	1010 0110	64.84	35.16	1.84
167	0xA7h	1010 0111	65.23	34.77	1.88
168	0xA8h	1010 1000	65.63	34.38	1.91
169	0xA9h	1010 1001	66.02	33.98	1.94
170	0xAAh	1010 1010	66.41	33.59	1.98
171	0xABh	1010 1011	66.80	33.20	2.01
172	0xACh	1010 1100	67.19	32.81	2.05
173	0ADh	1010 1101	67.58	32.42	2.08
174	0xAEh	1010 1110	67.97	32.03	2.12
175	0xAFh	1010 1111	68.36	31.64	2.16
176	0xB0h	1011 0000	68.75	31.25	2.20
177	0xB1h	1011 0001	69.14	30.86	2.24
178	0xB2h	1011 0010	69.53	30.47	2.28
179	0xB3h	1011 0011	69.92	30.08	2.32
180	0xB4h	1011 0100	70.31	29.69	2.37
181	0xB5h	1011 0101	70.70	29.30	2.41
182	0xB6h	1011 0110	71.09	28.91	2.46
183	0xB7h	1011 0111	71.48	28.52	2.51
184	0xB8h	1011 1000	71.88	28.13	2.56
185	0xB9h	1011 1001	72.27	27.73	2.61
186	0xBAh	1011 1010	72.66	27.34	2.66
187	0xBBh	1011 1011	73.05	26.95	2.71
188	0xBCh	1011 1100	73.44	26.56	2.76

Step	Hex	Binary	R _{WL} (kΩ)	R _{HW} (kΩ)	R _{WL} /R _{HW}
189	0xBDh	1011 1101	73.83	26.17	2.82
190	0xBEh	1011 1110	74.22	25.78	2.88
191	0xBFh	1011 1111	74.61	25.39	2.94
192	0xC0h	1100 0000	75.00	25.00	3.00
193	0xC1h	1100 0001	75.39	24.61	3.06
194	0xC2h	1100 0010	75.78	24.22	3.13
195	0xC3h	1100 0011	76.17	23.83	3.20
196	0xC4h	1100 0100	76.56	23.44	3.27
197	0xC5h	1100 0101	76.95	23.05	3.34
198	0xC6h	1100 0110	77.34	22.66	3.41
199	0xC7h	1100 0111	77.73	22.27	3.49
200	0xC8h	1100 1000	78.13	21.88	3.57
201	0xC9h	1100 1001	78.52	21.48	3.65
202	0xCAh	1100 1010	78.91	21.09	3.74
203	0xCBh	1100 1011	79.30	20.70	3.83
204	0xCCh	1100 1100	79.69	20.31	3.92
205	0xCDh	1100 1101	80.08	19.92	4.02
206	0xCEh	1100 1110	80.47	19.53	4.12
207	0xCFh	1100 1111	80.86	19.14	4.22
208	0xD0h	1101 0000	81.25	18.75	4.33
209	0xD1h	1101 0001	81.64	18.36	4.45
210	0xD2h	1101 0010	82.03	17.97	4.57
211	0xD3h	1101 0011	82.42	17.58	4.69
212	0xD4h	1101 0100	82.81	17.19	4.82
213	0xD5h	1101 0101	83.20	16.80	4.95
214	0xD6h	1101 0110	83.59	16.41	5.10
215	0xD7h	1101 0111	83.98	16.02	5.24
216	0xD8h	1101 1000	84.38	15.63	5.40
217	0xD9h	1101 1001	84.77	15.23	5.56
218	0xDAh	1101 1010	85.16	14.84	5.74
219	0xDBh	1101 1011	85.55	14.45	5.92
220	0xDCh	1101 1100	85.94	14.06	6.11
221	0xDDh	1101 1101	86.33	13.67	6.31
222	0xDEh	1101 1110	86.72	13.28	6.53
223	0xDFh	1101 1111	87.11	12.89	6.76
224	0xE0h	1110 0000	87.50	12.50	7.00
225	0xE1h	1110 0001	87.89	12.11	7.26
226	0xE2h	1110 0010	88.28	11.72	7.53
227	0xE3h	1110 0011	88.67	11.33	7.83
228	0xE4h	1110 0100	89.06	10.94	8.14
229	0xE5h	1110 0101	89.45	10.55	8.48
230	0xE6h	1110 0110	89.84	10.16	8.85
231	0xE7h	1110 0111	90.23	9.77	9.24
232	0xE8h	1110 1000	90.63	9.38	9.67
233	0xE9h	1110 1001	91.02	8.98	10.13
234	0xEAh	1110 1010	91.41	8.59	10.64
235	0xEBh	1110 1011	91.80	8.20	11.19
236	0xECh	1110 1100	92.19	7.81	11.80
237	0xEDh	1110 1101	92.58	7.42	12.47

Step	Hex	Binary	R _{WL} (kΩ)	R _{HW} (kΩ)	R _{WL} /R _{HW}
238	0xEEh	1110 1110	92.97	7.03	13.22
239	0xEFh	1110 1111	93.36	6.64	14.06
240	0xF0h	1111 0000	93.75	6.25	15.00
241	0xF1h	1111 0001	94.14	5.86	16.07
242	0xF2h	1111 0010	94.53	5.47	17.29
243	0xF3h	1111 0011	94.92	5.08	18.69
244	0xF4h	1111 0100	95.31	4.69	20.33
245	0xF5h	1111 0101	95.70	4.30	22.27
246	0xF6h	1111 0110	96.09	3.91	24.60
247	0xF7h	1111 0111	96.48	3.52	27.44
248	0xF8h	1111 1000	96.88	3.13	31.00
249	0xF9h	1111 1001	97.27	2.73	35.57
250	0xFAh	1111 1010	97.66	2.34	41.67
251	0xFBh	1111 1011	98.05	1.95	50.20
252	0xFC	1111 1100	98.44	1.56	63.00
253	0xFDh	1111 1101	98.83	1.17	84.33
254	0xFEh	1111 1110	99.22	0.78	127.00
255 (full-scale)	0xFFh	1111 1111	99.61	0.3	255.00

7.5 Programming with I²C

7.5.1 I²C General Operation

7.5.1.1 I²C Interface

The TPL0102 has a standard bidirectional I²C interface that is controlled by a microcontroller in order to configure the device and read the status of the device. Each device on the I²C bus, including this device, has a specific device address to differentiate between other devices that may be on the I²C bus. Configuration of the device is performed when the microcontroller addresses the device, then accesses the device's internal Register Maps, which have unique register addresses. The TPL0102 has multiple registers where data is stored, written, or read. Please refer to the Register Map for more details.

The physical I²C interface consists of the serial clock (SCL) and serial data (SDA) lines. Both SDA and SCL lines must be connected to VDD through a pull-up resistor. The size of the pull-up resistor is determined by the amount of capacitance on the I²C lines (for further details, please refer to the [I²C Bus Pullup Resistor Calculation](#) Application Report). Data transfer may be initiated only when the bus is not busy. For more detailed information on I²C, please refer to the [Understanding the I²C Bus](#) Application Report.

1. Suppose a master wants to send information to the TPL0102:
 - Master addresses TPL0102 (slave)
 - Master-transmitter sends data to TPL0102 (slave-receiver)
 - Master terminates the transfer.
2. If a master wants to receive information from TPL0102:
 - Master addresses TPL0102 (slave)
 - Master-receiver receives data from TPL0102 (slave-transmitter)
 - Master terminates the transfer.

The master generates the timing for the SCL.

7.5.1.2 START and STOP Conditions

I²C communication with this device is initiated by the master sending a START condition and terminated by the master sending a STOP condition. A high-to-low transition on the SDA line while the SCL is high defines a START condition. A low-to-high transition on the SDA line while the SCL is high defines a STOP condition.

Programming with I²C (continued)

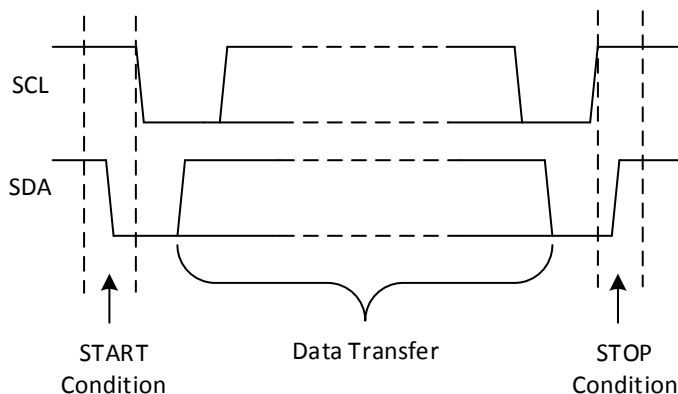


Figure 22. Definition of START and STOP Conditions

7.5.1.3 Data Validity and Byte Formation

One data bit is transferred during each clock pulse of the SCL. One byte is comprised of eight bits on the SDA line. A byte may either be a device address, register address, or data written to or read from a slave.

Data is transferred Most Significant Bit (MSB) first. Any number of data bytes can be transferred from the master to slave between the START and STOP conditions. Data on the SDA line must remain stable during the high phase of the clock period, as changes in the data line when the SCL is high are interpreted as control commands (START or STOP).

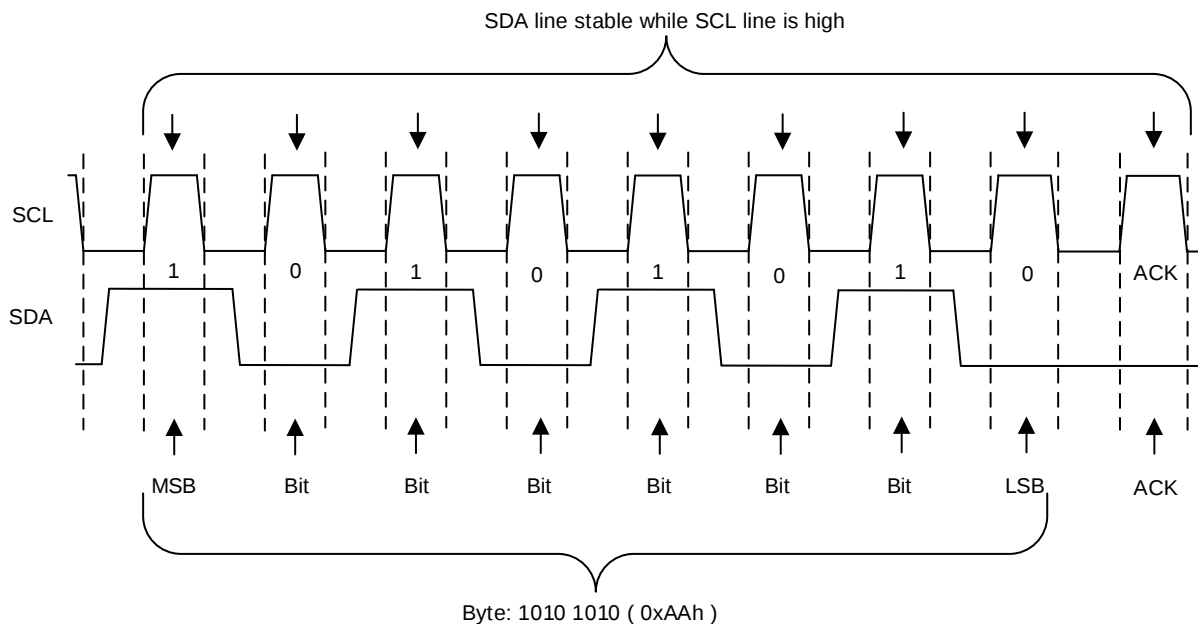


Figure 23. Definition of Byte Formation

7.5.1.4 Acknowledge (ACK) and Not Acknowledge (NACK)

Each byte is followed by one ACK bit from the receiver. The ACK bit allows the receiver to communicate to the transmitter that the byte was successfully received and another byte may be sent.

The transmitter must release the SDA line before the receiver can send the ACK bit. To send an ACK bit, the receiver shall pull down the SDA line during the low phase of the ACK/NACK-related clock period (period 9), so that the SDA line is stable low during the high phase of the ACK/NACK-related clock period. Setup and hold times must be taken into account.

Programming with I²C (continued)

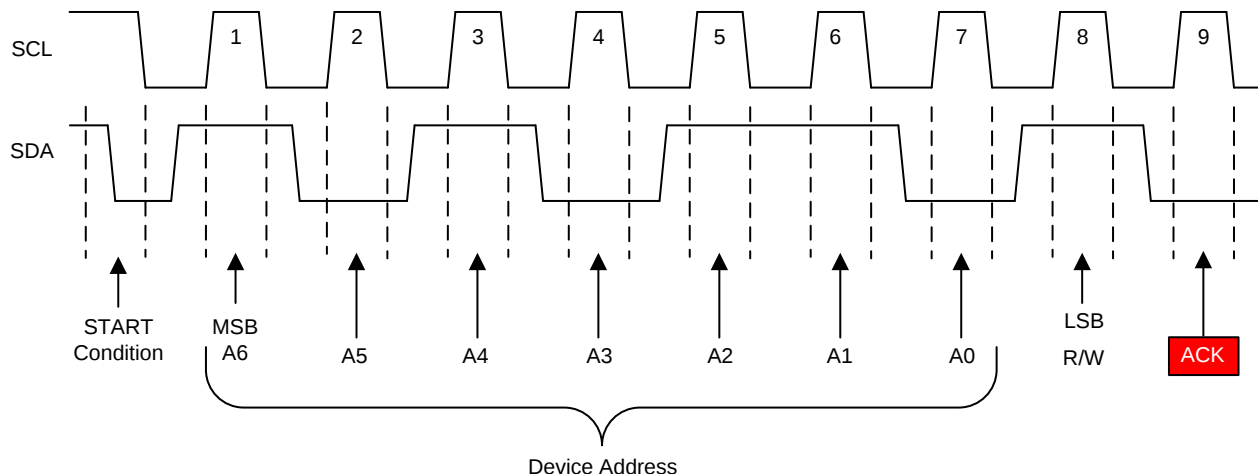


Figure 24. Example use of ACK

When the SDA line remains high during the ACK/NACK-related clock period, this is a NACK signal. There are several conditions that lead to the generation of a NACK:

- The receiver is unable to receive or transmit because it is performing some real-time function and is not ready to start communication with the master.
- During the transfer, the receiver gets data or commands that it does not understand.
- During the transfer, the receiver cannot receive any more data bytes.
- A master-receiver is done reading data and indicates this to the slave through a NACK.

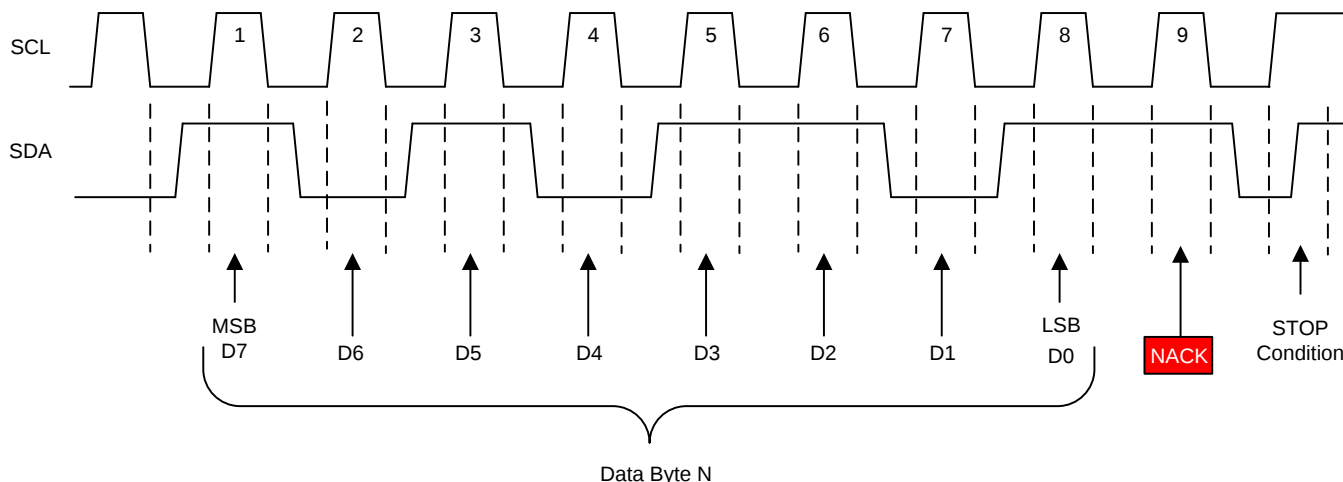


Figure 25. Example use of NACK

7.5.2 I²C Write and Read Operation

7.5.2.1 Auto Increment Function

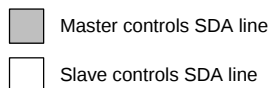
Auto increment allows multiple bytes to be written to or read from consecutive registers without requiring the master to repeatedly send the device address and register address for each data byte. This is beneficial because auto increment substantially reduces the number of bytes transferred between the master and slave.

For the TPL0102, the registers will auto increment as long as the user continues to enter data. Auto increment will stop once the user is finished entering data bytes.

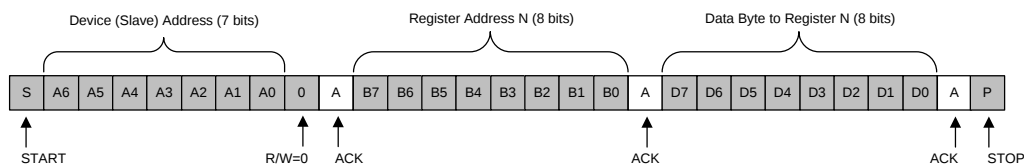
Programming with I²C (continued)

If there are more bytes to write or read after the last register address is written to or read from in the register map, auto increment will loop around to the register address at the beginning of the register map. For example, after the ACR (register address 0x10h) has been written to, if there are more bytes to be written, the register address will loop to the IVRA (register address 0x00h) at the beginning of the register map.

7.5.2.2 Write Operation



Write to one register in a device



Write to multiple registers in a device

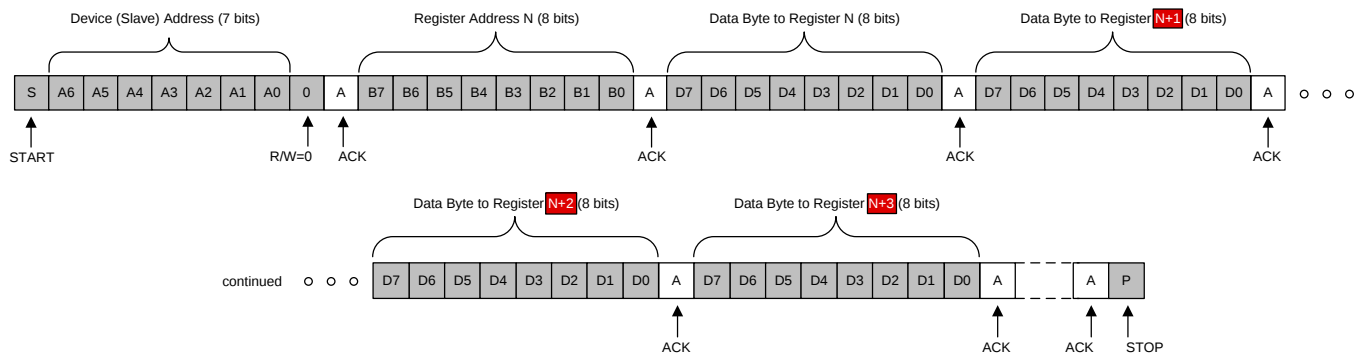


Figure 26. Write Operation to One or Multiple Registers

7.5.2.3 Repeated Start

A repeated START condition may be used in place of a complete STOP condition followed by another START condition when performing a read function. The advantage of this is that the I²C bus does not become available after the stop and therefore prevents other devices from grabbing the bus between transfers.

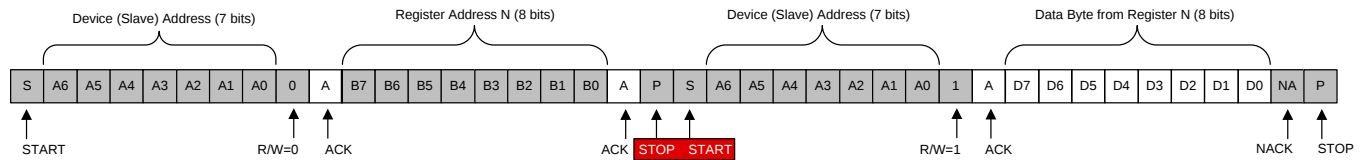
Programming with I²C (continued)

7.5.2.4 Read Operation

Master controls SDA line

Slave controls SDA line

Read from one register in a device



Read from one register in a device (Repeated Start)

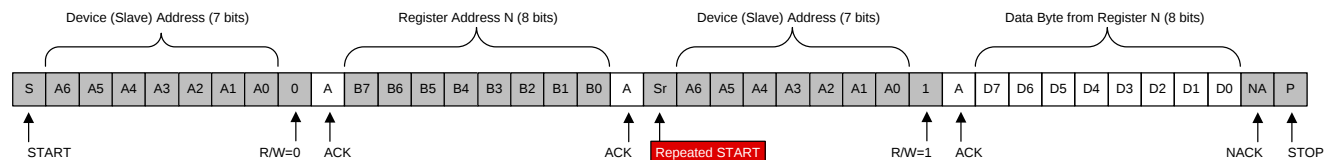
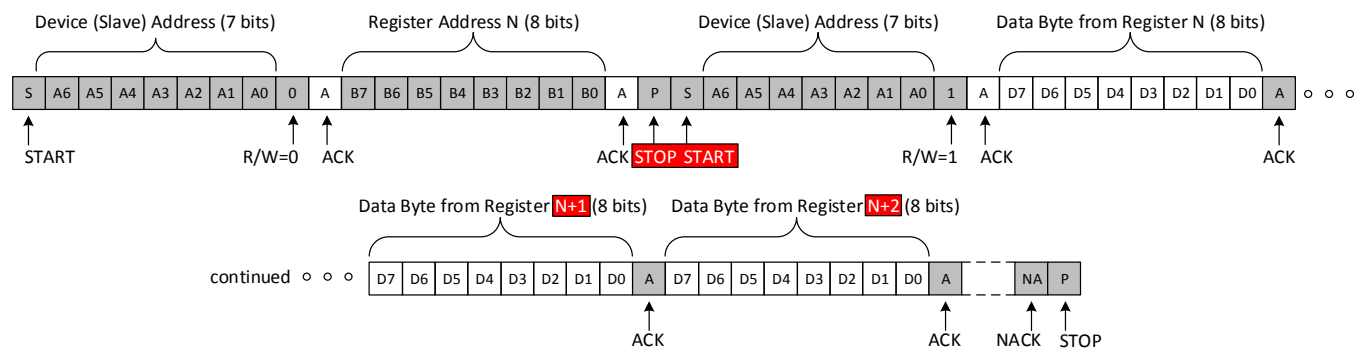


Figure 27. Read Operation from One Register

Read from multiple registers in a device



Read from multiple registers in a device (Repeated Start)

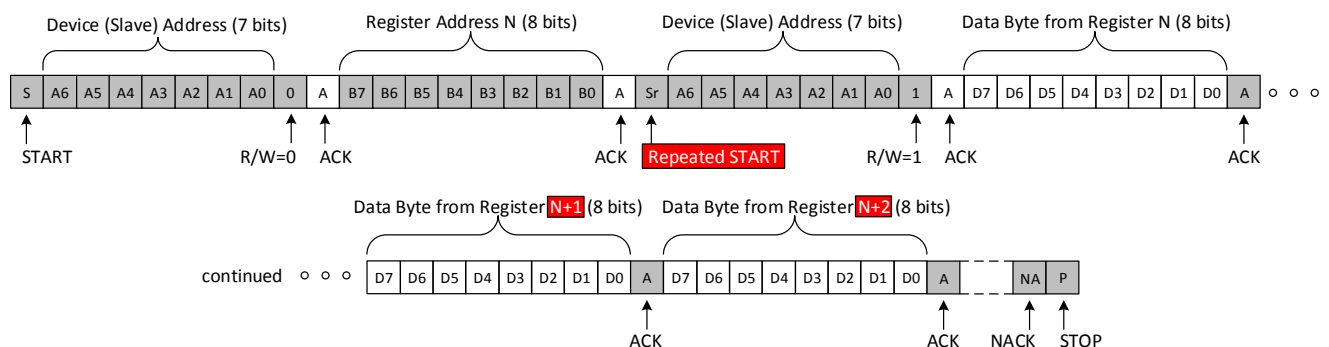


Figure 28. Read Operation from Multiple Registers

7.6 Register Maps

7.6.1 Slave Address

The device (slave) address can be configured by the user with 3 bits (A2, A1, and A0), allowing for 8 different possibilities for the device address. Please see the [Figure 30](#) for an example.

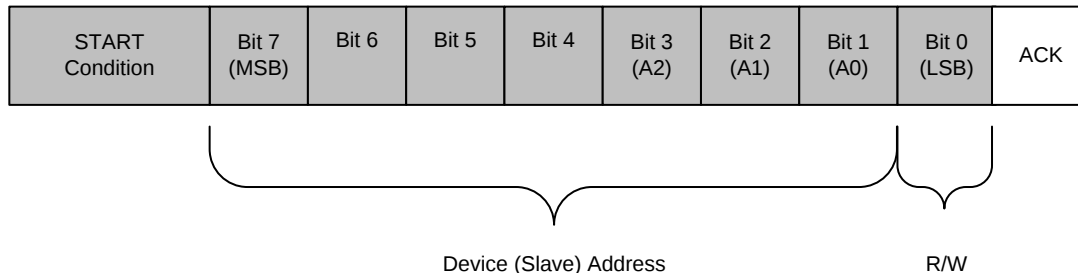


Figure 29. Device Address in Context with START and ACK

Bit 7 (MSB)	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0 (LSB)
1	0	1	0	A2	A1	A0	R/W

[Figure 30](#) shows an example of how to configure A2, A1 and A0 to give unique device addresses on the same I²C bus. When a bit is wired to Vcc, this gives that bit a value of 1. When a bit is wired to GND, this gives that bit a value of 0.

For example, Device 1 could be the TPL0102 on the I²C bus, which would have a 7 bit device address of 1010 110. There are some interfaces that will require the device address to be inputted in hex. In order to make the device address 8 bits for hex notation, a leading 0 is added to the left of the 7 bit device address. For Device 1, the 8 bit device address is 0101 0110 (0x56h). Device 2 would have a 7 bit device address of 1010 100, which with a leading 0 results in an 8 bit device address of 0101 0100 (0x54h). Device 3 would have a 7 bit device address of 1010 011, and with a leading 0 results in an 8 bit device address of 0101 0011 (0x53h).

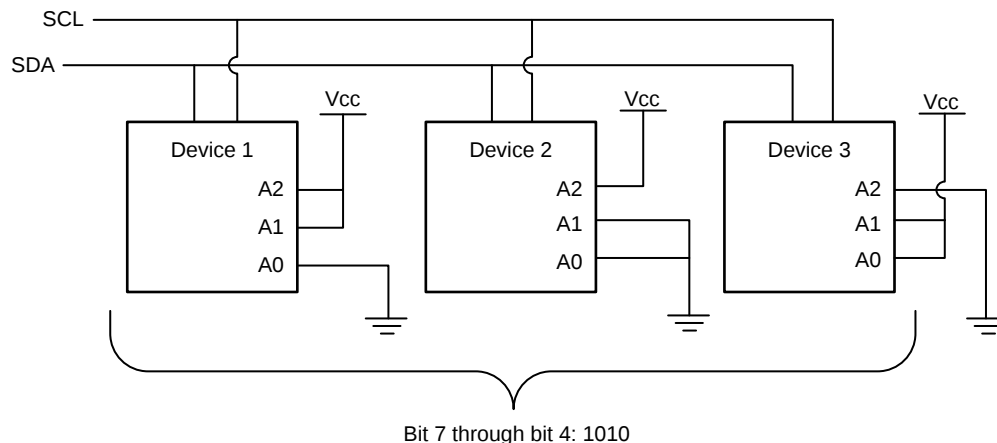


Figure 30. Examples of Device Address Configuration on I²C Bus

7.6.2 TPL0102 Register Map

- When writing the entire register map using auto increment, general purpose registers in the register address map need to be written with dummy bytes. The general purpose registers do not effect the outputs of the potentiometers.
- As stated in the [Overview](#), the VOL bit from the [ACR \(Access Control Register\)](#) provides two options for register accessibility. Either only volatile registers (WR) are accessible to change the wiper setting without storing the value in non-volatile memory or volatile registers (WR) and non-volatile registers (IVR) are accessible to change the wiper setting, which allows the value to be stored in non-volatile memory.
- The respective non-volatile and volatile registers have the same register address, thus to write to both the volatile and non-volatile locations, only one register address needs to be entered and the VOL bit needs to be configured properly.

REGISTER ADDRESS (HEX)	REGISTER ADDRESS (BINARY)	NON-VOLATILE	VOLATILE
0x00h	0000 0000	IVRA	WRA
0x01h	0000 0001	IVRB	WRB
0x02h	0000 0010	General purpose	N/A
0x03h	0000 0011	General purpose	N/A
0x04h	0000 0100	General purpose	N/A
0x05h	0000 0101	General purpose	N/A
0x06h	0000 0110	General purpose	N/A
0x07h	0000 0111	General purpose	N/A
0x08h	0000 1000	General purpose	N/A
0x09h	0000 1001	General purpose	N/A
0x0Ah	0000 1010	General purpose	N/A
0x0Bh	0000 1011	General purpose	N/A
0x0Ch	0000 1100	General purpose	N/A
0x0Dh	0000 1101	General purpose	N/A
0x0Eh	0000 1110	General purpose	N/A
0x0Fh	0000 1111		Reserved
0x10h	0001 0000	N/A	ACR

7.6.3 IVRA (Initial Value Register for Potentiometer A)

- Non-volatile register to store wiper position for potentiometer A
- Register will hold value even when device is powered down

NAME	TYPE	SIZE (BITS)	REGISTER ADDRESS	FACTORY PROGRAMMED VALUE
IVRA	Non-volatile Write/Read	8	0x00h	0x80h

7.6.4 WRA (Wiper Resistance Register for Potentiometer A)

- Volatile register to change wiper position for potentiometer A
- IVRA loads value to WRA to determine wiper position

NAME	TYPE	SIZE (BITS)	REGISTER ADDRESS	VALUE UPON RESET
WRA	Volatile Write/Read	8	0x00h	IVRA value

7.6.5 IVRB (Initial Value Register for Potentiometer B)

- Non-volatile register to store wiper position for potentiometer B
- Register will hold value even when device is powered down

NAME	TYPE	SIZE (BITS)	REGISTER ADDRESS	FACTORY PROGRAMMED VALUE
IVRB	Non-volatile Write/Read	8	0x01h	0x80h

7.6.6 WRB (Wiper Resistance Register for Potentiometer B)

- Volatile register to change wiper position for potentiometer B
- IVRB loads value to WRB to determine wiper position

NAME	TYPE	SIZE (BITS)	REGISTER ADDRESS	VALUE UPON RESET
WRB	Volatile Write/Read	8	0x01h	IVRB value

7.6.7 ACR (Access Control Register)

- Volatile register to control register access, determine shut-down mode, and read non-volatile write operations

NAME	TYPE	SIZE (BITS)	REGISTER ADDRESS	VALUE UPON RESET
ACR	Volatile Write/Read	8	0x10h	0x40h

NAME	BIT ASSIGNMENT							
ACR	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
	VOL	$\overline{\text{SHDN}}$	WIP	0	0	0	0	0
Reset (Default) Value	0	1	0	0	0	0	0	0

NAME	TYPE	SIZE (BITS)	BIT VALUE	DESCRIPTION
VOL	Volatile Write/Read	1	0	Non-volatile registers (IVRA, IVRB) are accessible. Value written to IVR register is also written to the corresponding WR. If read operation is performed, only non-volatile register (IVRA, IVRB) values will be reported.
			1	Only Volatile Registers (WR) are accessible. If read operation is performed, only volatile (WRA, WRB) values will be reported.
$\overline{\text{SHDN}}$	Volatile Write/Read	1	0	Shutdown mode is enabled. Both potentiometers are in shutdown mode. (see Shutdown Mode)
			1	Shutdown mode is disabled
WIP	Volatile Read	1	0	Non-volatile write operation is not in progress
			1	Non-volatile write operation is in progress (it is not possible to write to the WR or ACR while WIP = 1)

8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

There are many applications in which variable resistance or voltage division is needed through the use of a digital potentiometer such as the TPL0102; these are just a few examples. In conjunction with various amplifiers, the TPL0102 can effectively be used in rheostat mode to modify the gain of an amplifier, in voltage divider mode to create a Digital to Analog Converter, or one of the potentiometers can be used in voltage divider mode while the other is in rheostat mode to create a variable current sink.

8.2 Typical Applications

8.2.1 Adjustable Gain Non-Inverting Amplifier

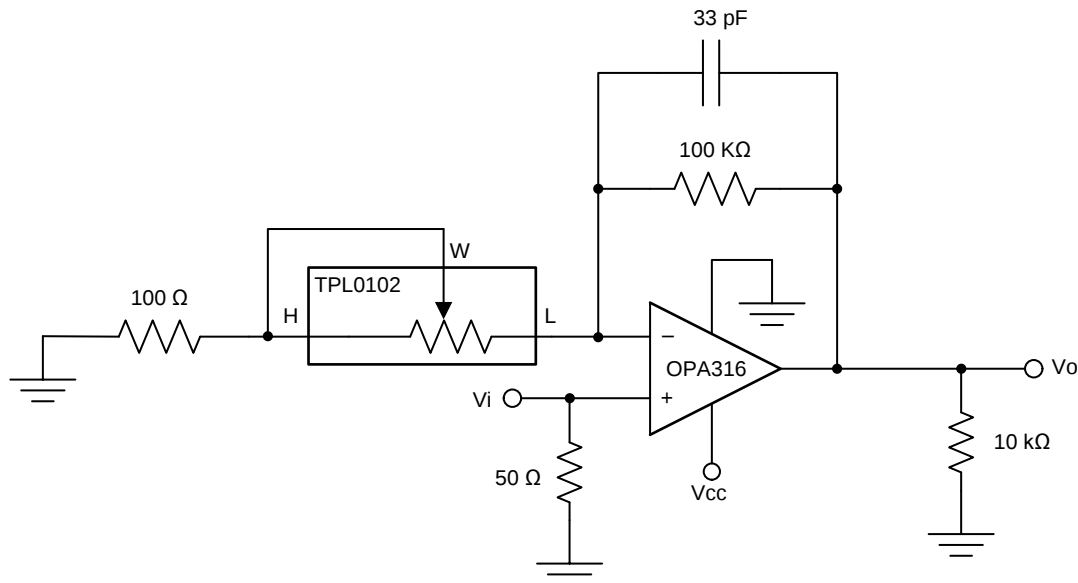


Figure 31. Gain Control Compensation Schematic

8.2.1.1 Design Requirements

DESIGN PARAMETER	EXAMPLE VALUE
Gain range	6 to 60 dB

8.2.1.2 Detailed Design Procedure

The TPL0102 can be used in rheostat mode with an OPA316 to create an adjustable gain non-inverting amplifier. The capacitor and resistor values were chosen based upon the Non-Inverting Amplifier Gain equation:

$$\text{Gain} = 1 + \frac{Z_f}{Z_{in}} \quad (5)$$

Where Z_{in} is the impedance between the inverting input and GND and Z_f is the impedance of the feedback network.

In this application, the following equations are used:

$$Z_{in} = \text{TPL0102 resistance} + 100 \, \Omega \quad (6)$$

and

$$Z_f = R_f \parallel C_f \quad (7)$$

Where R_f and C_f are the feedback resistor and capacitor, respectively.

A 100 Ω resistor is added in series with the TPL0102 resistance in order to stop the op amp from producing infinite gain. When the TPL0102 is at zero-scale, the resistance between terminal L and terminal W is $\sim 0 \, \Omega$. This would normally cause infinite gain, but with the 100 Ω resistor in series, the lowest Z_{in} can be is 100 Ω , which at DC will create a gain of roughly 60 dB.

$$\text{Gain} = 1 + \frac{100 \, \text{k}\Omega}{\sim 0 \, \Omega + 100 \, \Omega} = 1 + \frac{100 \, \text{k}\Omega}{100 \, \Omega} = 1 + 1000 = 1001 \frac{V}{V} \cong 60 \, \text{dB} \quad (8)$$

R_f and C_f were chosen based upon characteristics of the potentiometer and op amp, respectively. The value of R_f affects the level of gain, primarily at low frequencies. Since the TPL0102 has a full-scale resistance of 100 k Ω between terminal W and terminal L, the R_f was chosen to match this full-scale resistance, which produces the minimum gain of 6 dB:

$$\text{Gain} = 1 + \frac{100 \, \text{k}\Omega}{100 \, \text{k}\Omega + 100 \, \Omega} \cong 1 + \frac{100 \, \text{k}\Omega}{100 \, \text{k}\Omega} = 1 + 1 = 2 \frac{V}{V} \cong 6 \, \text{dB} \quad (9)$$

As frequency increases, C_f begins to have an impact on gain. A frequency roll-off will occur due to the open-loop gain of the op amp, but in this application, the desired effect is to have C_f impact the roll off before the open loop gain of the op amp. At a gain of 40 dB, the op amp open loop gain will force the roll off to occur at 100 kHz. Therefore, in order for C_f to impact the roll off before the open loop gain, roll off due to the capacitor must occur at less than 100 kHz. In this application, 50 kHz is the desired roll off frequency, resulting in a C_f value of 33 pF.

$$C_f = \frac{1}{2 \times \pi \times R_f \times f(-3 \, \text{dB})} = \frac{1}{2 \times \pi \times 100 \, \text{k}\Omega \times 50 \, \text{kHz}} = 33 \, \text{pF} \quad (10)$$

Measurements were taken with a 10 k Ω load. A 50 Ω resistor is included at the input for termination of measurement equipment.

8.2.1.3 Application Curves

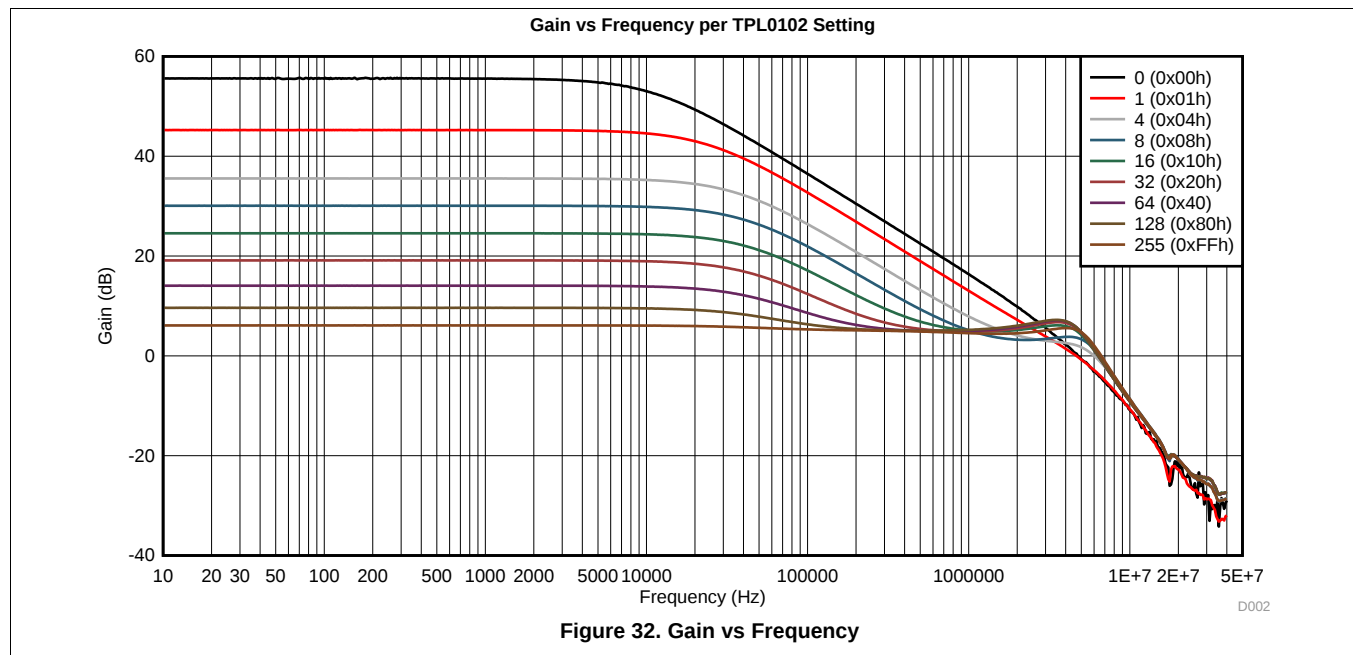
As the TPL0102 moves from full-scale to zero-scale, Z_{in} decreases, which causes the gain of the op amp to increase from 6 dB to 56 dB. The amplifier does not reach the full 60 dB of calculated gain because the resistance in the TPL0102 did not reach 0 Ω . At zero-scale, the TPL0102 had a remaining resistance of approximately 58 Ω .

$$\text{Gain} = 1 + \frac{100 \, \text{k}\Omega}{58 \, \Omega + 100 \, \Omega} = 1 + \frac{100 \, \text{k}\Omega}{158 \, \Omega} = 1 + 633 = 634 \frac{V}{V} \cong 56 \, \text{dB} \quad (11)$$

The application curve clearly shows the effect of the low pass filter created by the R_f and C_f combination. Roll off begins as frequencies approach 50 kHz because of the pole created by the 33 pF capacitor. As the frequency increases beyond 50 kHz, the gain decreases by -20 dB/dec until the gain levels off at 1V/V or 0dB. The gain levels off due to the nature of non-inverting op amp transfer functions. The feedback impedance, Z_f , is approximately zero at high frequency because C_f acts as a short. As shown below, this results in a gain of 0 dB:

$$\text{Gain} = 1 + \frac{Z_f}{Z_{in}} = 1 + \frac{\sim 0}{Z_{in}} = 1 \frac{V}{V} = 0 \, \text{dB} \quad (12)$$

At approximately 3 MHz, the gain is again reduced by -20 dB/dec due to the pole created by open-loop gain of the OPA316.



8.2.2 Digital to Analog Converter (DAC)

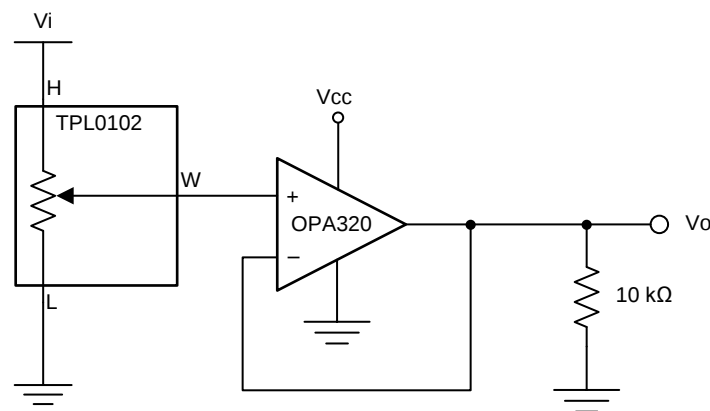


Figure 33. Digital to Analog Converter Schematic

8.2.2.1 Design Requirements

DESIGN PARAMETER	EXAMPLE VALUE
Input Voltage Range	0 to 5 V
Output Voltage Range	0 to 5 V

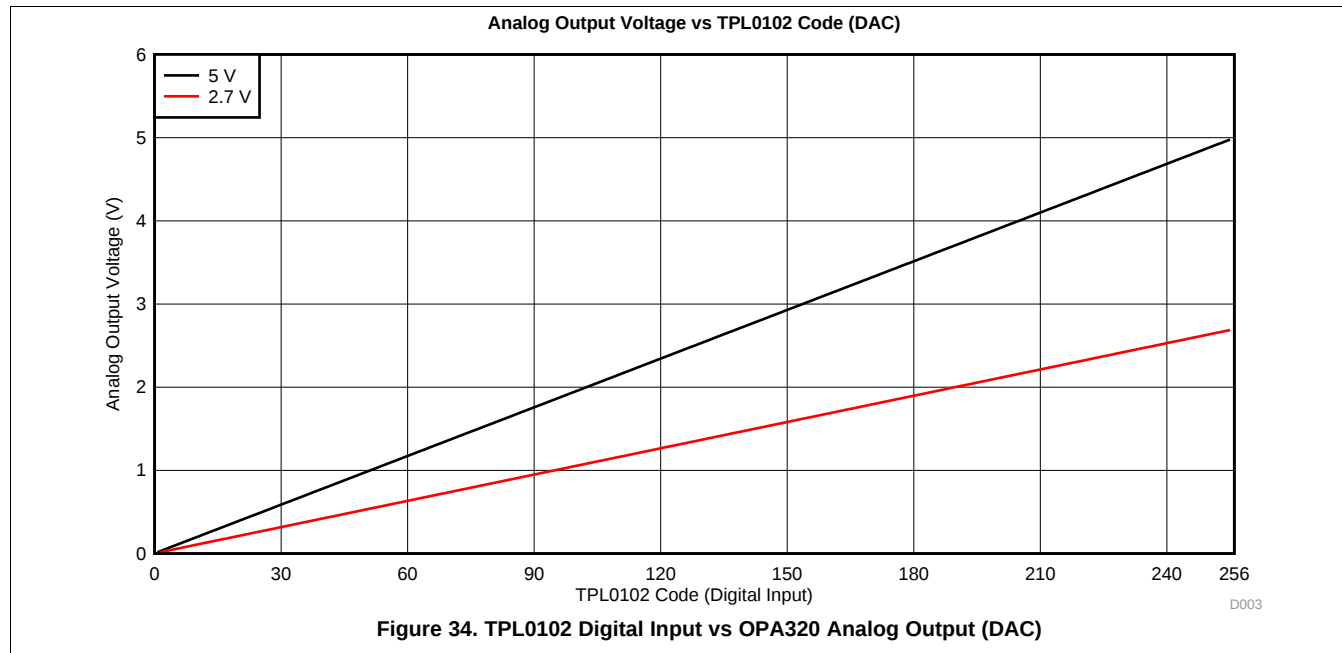
8.2.2.2 Detailed Design Procedure

The TPL0102 can be used in voltage divider mode with a unity-gain op amp buffer to create an 8-bit Digital to Analog Converter (DAC). The analog output voltage of the circuit is determined by the wiper setting programmed through the I²C bus.

The op amp is required to buffer the high-impedance output of the TPL0102 or else loading placed on the output of the voltage divider will affect the output voltage.

8.2.2.3 Application Curves

The voltage at terminal H determines the maximum analog voltage at the output. As the TPL0102 moves from zero-scale to full-scale, the voltage divider adjusts with relation to the voltage divider formula ([Equation 1](#)), resulting in the desired voltage at terminal W. The voltage at terminal W will range linearly from 0 V to the terminal H voltage. In this example, V_{in} at terminal H is 5 V and 2.7 V.



8.2.3 Variable Current Sink

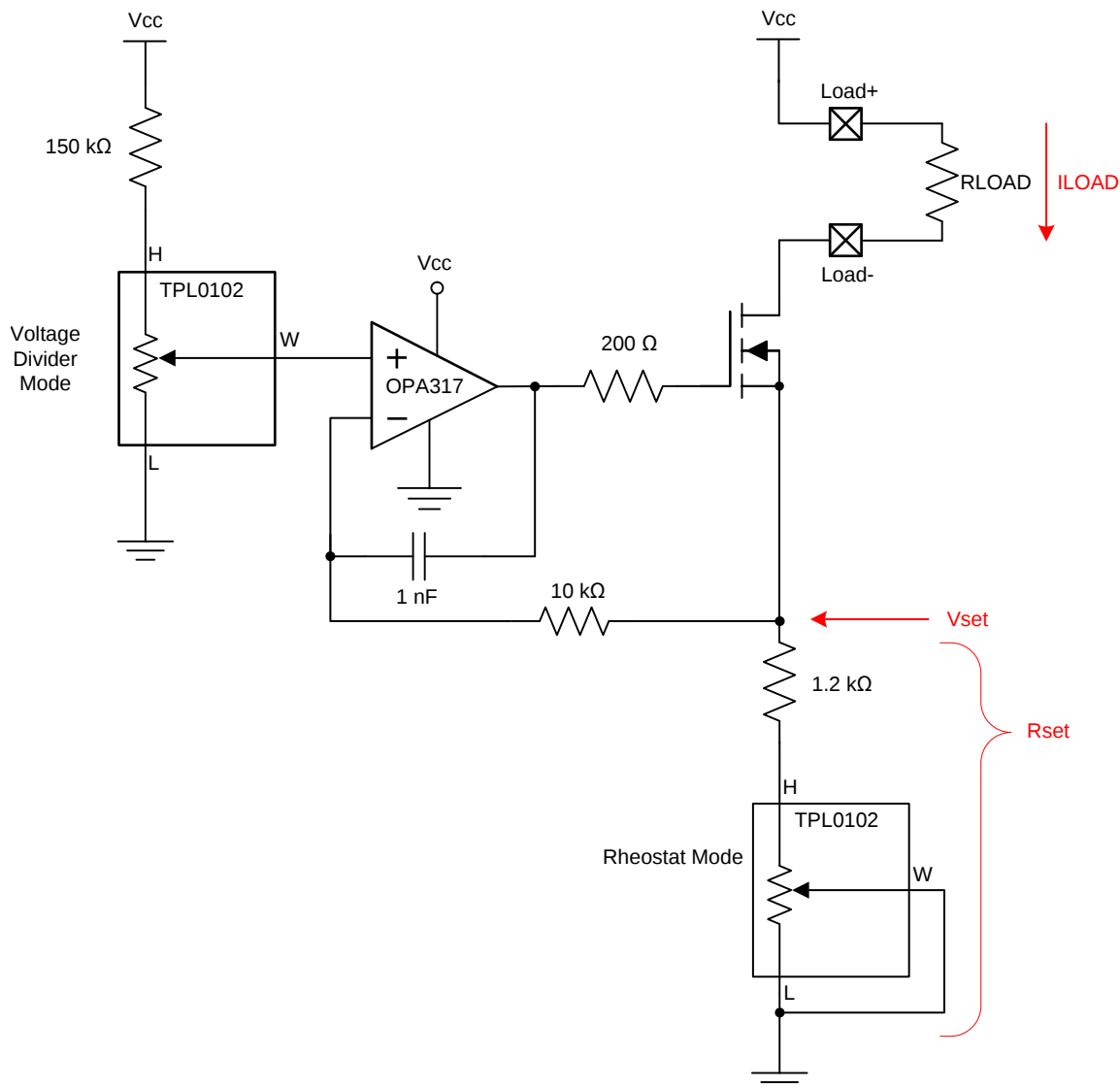


Figure 35. Variable Current Sink Schematic

8.2.3.1 Design Requirements

DESIGN PARAMETER	EXAMPLE VALUE
Load Current Range	0 μ A to 1.33 mA

8.2.3.2 Detailed Design Procedure

Both potentiometers within the TPL0102 can be used with an OPA317 op amp and N-Channel MOSFET to produce a variable current sink. The first potentiometer, configured in voltage divider mode, is used to set the input voltage to the OPA317. The second potentiometer, configured in rheostat mode, is used to set the span of the current (I_{LOAD}) running through R_{LOAD} . The load current for the circuit is shown below:

$$I_{LOAD} = \frac{V_{set}}{R_{set}} \quad (13)$$

Based upon the voltage divider formula between the setting of the TPL0102 and the 150 kΩ resistor, the voltage at the positive input of the OPA317, V_{set} , can range from 0 to 2 V. This leaves a maximum of 3 V of voltage drop from the positive side to the negative side of the external load with a 5 V supply. A 1.2 kΩ resistor is placed in series with the TPL0102 span setting potentiometer (R_{set}). At full scale of the span setting potentiometer and the maximum voltage at V_{set} (2 V), the maximum value for I_{LOAD} is:

$$I_{LOAD_MAX} = \frac{V_{set}}{R_{set}} = \frac{V_{set}}{TPL0102_{HW(Resistance)} + 1.2\text{ k}\Omega} = \frac{2\text{ V}}{300\text{ }\Omega + 1.2\text{ k}\Omega} = 1.33\text{ mA} \quad (14)$$

When the span setting potentiometer is at zero scale with the maximum voltage at V_{set} , the maximum value for I_{LOAD} is:

$$I_{LOAD} = \frac{V_{set}}{R_{set}} = \frac{V_{set}}{TPL0102_{HW(Resistance)} + 1.2\text{ k}\Omega} = \frac{2\text{ V}}{100\text{ k}\Omega + 1.2\text{ k}\Omega} = 19.76\text{ }\mu\text{A} \quad (15)$$

The same calculations can be made when the potentiometer in voltage divider mode is a zero scale. At zero scale, V_{set} will be almost negligible, resulting in 0 A of current no matter the value of the span setting potentiometer.

8.2.3.2.1 Compensation Components

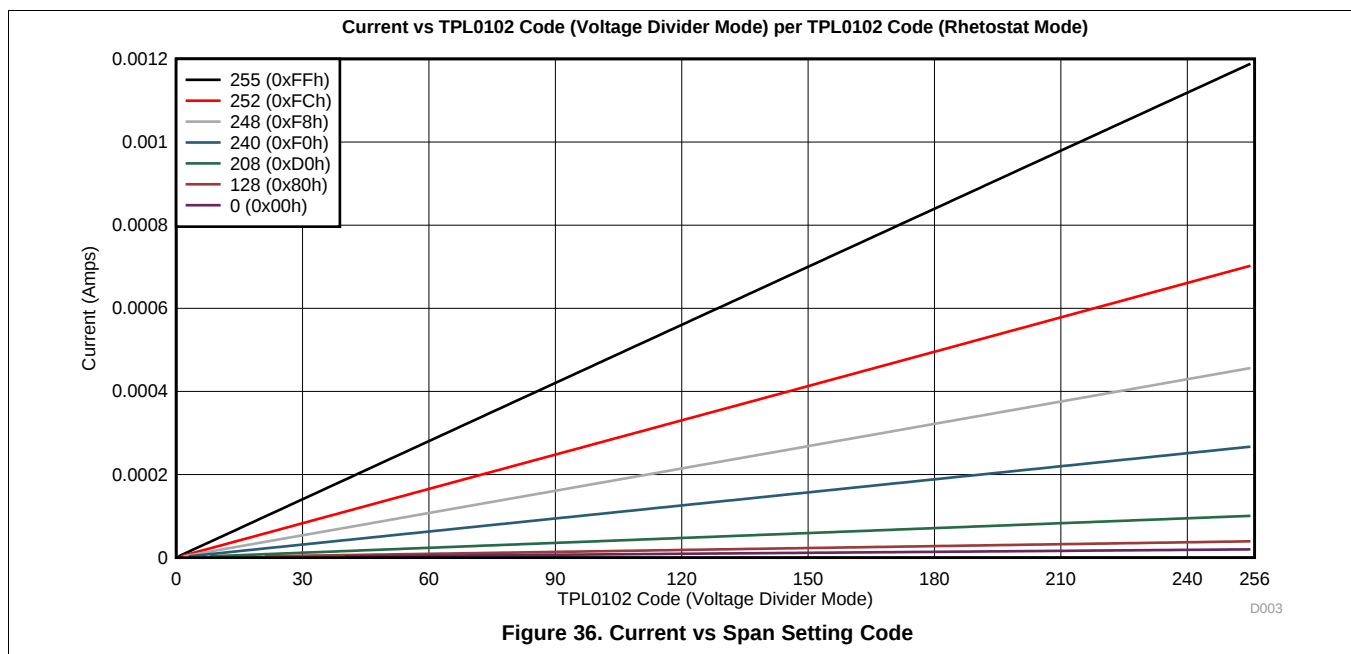
This design requires a few compensation components to stabilize the feedback network. These include the 1 nF capacitor and the 200 Ω and 10 kΩ resistors, which were selected based upon the [TIPD102 reference design](#).

8.2.3.3 Application Curves

As the TPL0102 in rheostat mode (span setting potentiometer) moves from zero-scale to full-scale, a new step (line) is created with a larger achievable maximum current. The rheostat mode potentiometer directly corresponds to R_{set} in Equation 13. The TPL0102 in voltage divider mode produces the granular current values between the minimum and maximum range. The voltage divider potentiometer directly corresponds to V_{set} in Equation 13. For example, when the potentiometer in rheostat mode is at code 256, the potentiometer in voltage divider mode produces a theoretical maximum current of 1.33 mA at code 256 and a minimum current of 0 μA at code 0.

The current sink does not reach the full 1.33 mA because of the error in resistance of the span setting potentiometer. At full-scale, the resistor had an actual resistance of 480 Ω.

$$I_{LOAD_MAX} = \frac{V_{set}}{R_{set}} = \frac{V_{set}}{TPL0102_{HW(Resistance)} + 1.2\text{ k}\Omega} = \frac{2\text{ V}}{480\text{ }\Omega + 1.2\text{ k}\Omega} = 1.19\text{ mA} \quad (16)$$



9 Power Supply Recommendations

9.1 Power Sequence

Protection diodes limit the voltage compliance at terminal H, terminal L, and terminal W, making it important to power up V_{DD} first before applying any voltage to terminal H, terminal L, and terminal W. The diodes are forward-biasing, meaning V_{DD} can be powered unintentionally if V_{DD} is not powered first. The ideal power-up sequence is V_{SS} , V_{DD} , V_{LOGIC} , digital inputs, and V_H , V_L , and V_W . The order of powering digital inputs, V_H , V_L , and V_W does not matter as long as they are powered after V_{SS} , V_{DD} , and V_{LOGIC} .

9.2 Wiper Position Upon Power Up

It is prudent to know that when the DPOT is powered off, the impedance of the device is not known. Upon power up, the device will go to 0x80h code for a very short period of time while it loads the stored wiper position in the EEPROM and then will go to the stored position. This happens in less than 100 μ S.

9.3 Dual-Supply vs Single-Supply

Dual-supply operation allows the TPL0102 to handle voltage that may swing negative. This is especially useful for any application that involves negative voltages, such as the input to an Op Amp or audio signals. It is recommended that V_{SS} (negative supply) is mirrored with V_{DD} (positive supply) and both are centered around GND. For example, if dual-supply is desired and $V_{DD} = 2.50$ V, then V_{SS} should be equal to -2.50 V, which will result in GND centered between V_{DD} and V_{SS} .

Single-supply operation allows the TPL0102 to handle positive voltages only. In single-supply, it is recommended that V_{SS} is tied to GND.

10 Layout

10.1 Layout Guidelines

To ensure reliability of the device, please follow common printed-circuit board layout guidelines.

- Leads to the input should be as direct as possible with a minimum conductor length.
- The ground path should have low resistance and low inductance.
- Short trace-lengths should be used to avoid excessive loading.
- It is common to have a dedicated ground plane on an inner layer of the board.
- Terminals that are connected to ground should have a low-impedance path to the ground plane in the form of wide polygon pours and multiple vias.
- Bypass capacitors should be used on power supplies and should be placed as close as possible to the VDD and VSS pins.
- Apply low equivalent series resistance 0.1 μ F to 10 μ F tantalum or electrolytic capacitors at the supplies to minimize transient disturbances and to filter low frequency ripple.
- To reduce the total I²C bus capacitance added by PCB parasitics, data lines (SCL and SDA) should be a short as possible and the widths of the traces should also be minimized (e.g. 5-10 mils depending on copper weight).

10.2 Layout Example

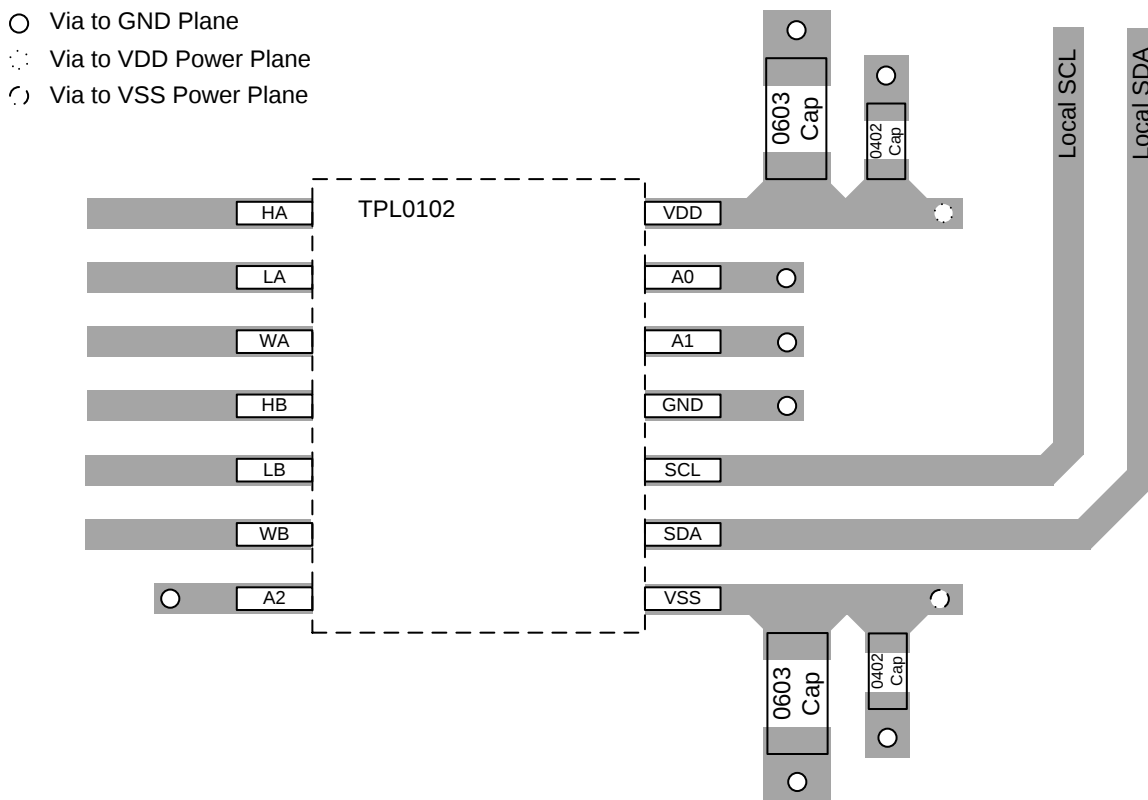


Figure 37. TPL0102 Layout Example

11 器件和文档支持

11.1 社区资源

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

11.2 商标

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

11.3 静电放电警告



这些装置包含有限的内置 ESD 保护。存储或装卸时，应将导线一起截短或将装置放置于导电泡棉中，以防止 MOS 门极遭受静电损伤。

11.4 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

12 机械、封装和可订购信息

以下页中包括机械、封装和可订购信息。这些信息是针对指定器件可提供的最新数据。这些数据会在无通知且不对本文档进行修订的情况下发生改变。欲获得该数据表的浏览器版本，请查阅左侧的导航栏。

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TPL0102-100PWR	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	EL-100	Samples
TPL0102-100RUCR	ACTIVE	QFN	RUC	14	3000	RoHS & Green	NIPDAUAG	Level-1-260C-UNLIM	-40 to 85	6NH	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

⁽²⁾ **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPL0102-100PWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
TPL0102-100RUCR	QFN	RUC	14	3000	180.0	8.4	2.3	2.3	0.55	4.0	8.0	Q2

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPL0102-100PWR	TSSOP	PW	14	2000	356.0	356.0	35.0
TPL0102-100RUCR	QFN	RUC	14	3000	202.0	201.0	28.0

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



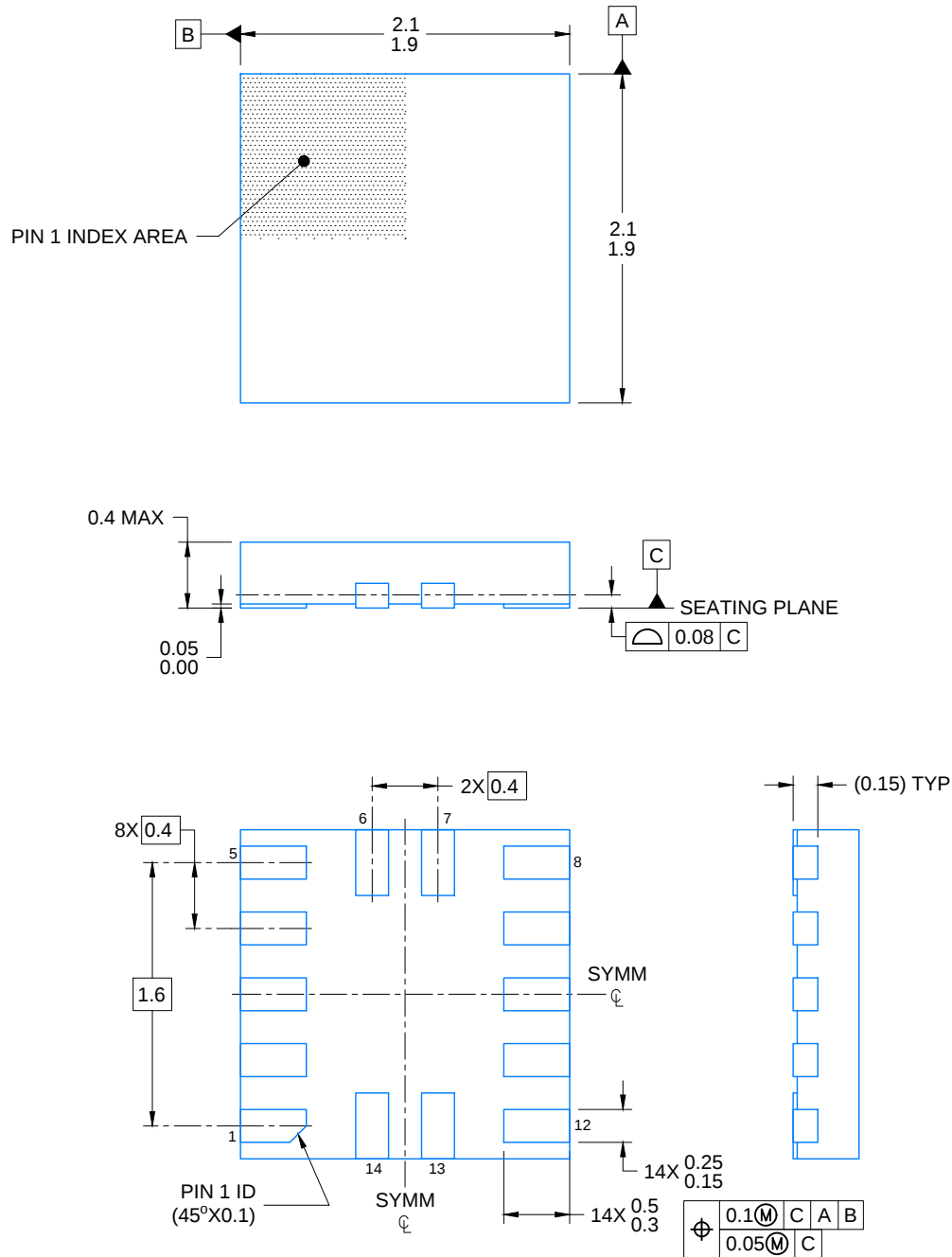
4040064-3/G 02/11

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



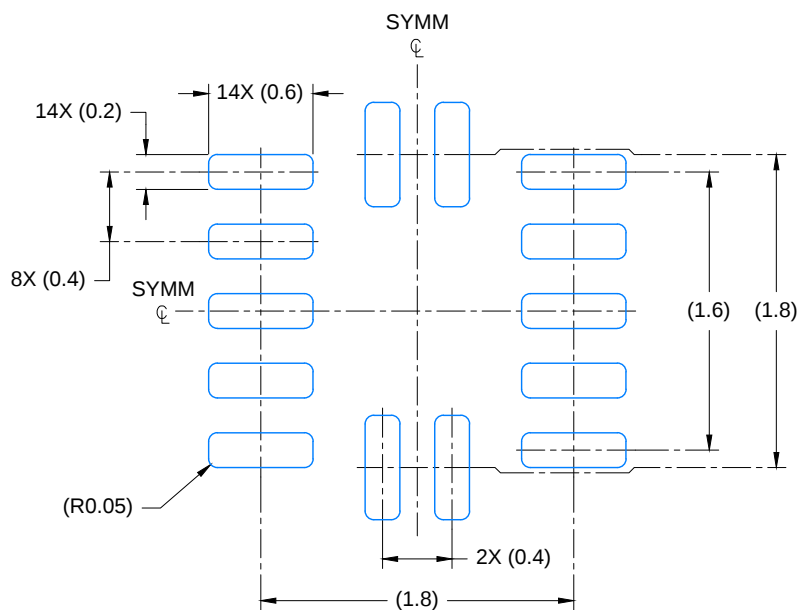
- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Publication IPC-7351 is recommended for alternate designs.
 - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



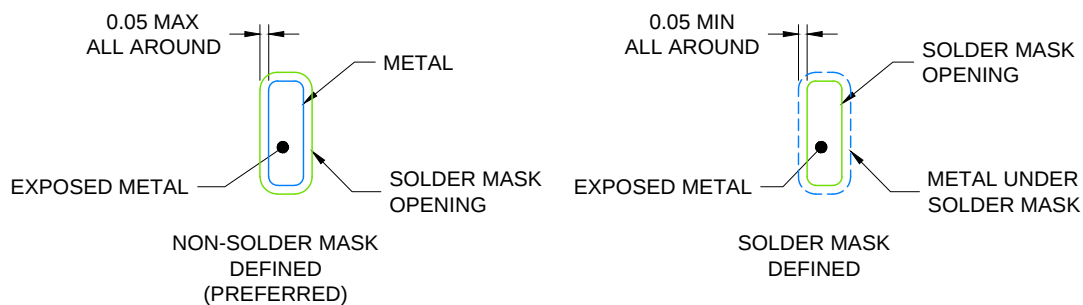
4220584/A 05/2019

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 23X



SOLDER MASK DETAILS

4220584/A 05/2019

NOTES: (continued)

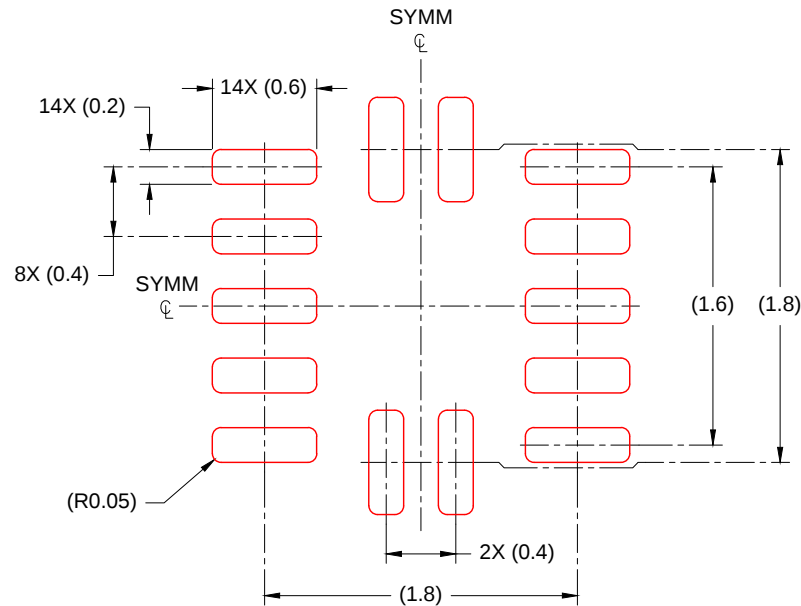
- For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/sluea271).

EXAMPLE STENCIL DESIGN

RUC0014A

X2QFN - 0.4 mm max height

PLASTIC QUAD FLAT PACK- NO LEAD



SOLDER PASTE EXAMPLE
BASED ON 0.100mm THICK STENCIL
SCALE: 23X

4220584/A 05/2019

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

重要声明和免责声明

TI“按原样”提供技术和可靠性数据（包括数据表）、设计资源（包括参考设计）、应用或其他设计建议、网络工具、安全信息和其他资源，不保证没有瑕疵且不做任何明示或暗示的担保，包括但不限于对适销性、某特定用途方面的适用性或不侵犯任何第三方知识产权的暗示担保。

这些资源可供使用 TI 产品进行设计的熟练开发人员使用。您将自行承担以下全部责任：(1) 针对您的应用选择合适的 TI 产品，(2) 设计、验证并测试您的应用，(3) 确保您的应用满足相应标准以及任何其他功能安全、信息安全、监管或其他要求。

这些资源如有变更，恕不另行通知。TI 授权您仅可将这些资源用于研发本资源所述的 TI 产品的应用。严禁对这些资源进行其他复制或展示。您无权使用任何其他 TI 知识产权或任何第三方知识产权。您应全额赔偿因在这些资源的使用中对 TI 及其代表造成的任何索赔、损害、成本、损失和债务，TI 对此概不负责。

TI 提供的产品受 [TI 的销售条款](#) 或 [ti.com](#) 上其他适用条款/TI 产品随附的其他适用条款的约束。TI 提供这些资源并不会扩展或以其他方式更改 TI 针对 TI 产品发布的适用的担保或担保免责声明。

TI 反对并拒绝您可能提出的任何其他或不同的条款。

邮寄地址：Texas Instruments, Post Office Box 655303, Dallas, Texas 75265

Copyright © 2022，德州仪器 (TI) 公司